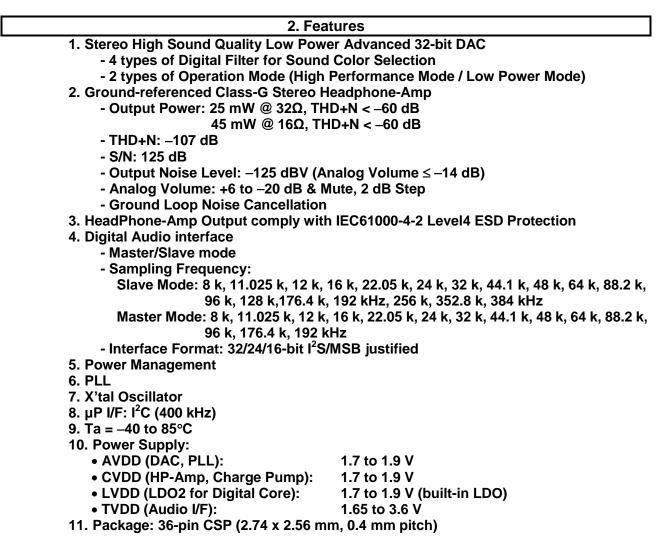


AK4376A Low-Power Advanced 32-bit DAC with HP

1. General Description

The AK4376A is stereo advanced 32-bit high sound quality audio DAC with a built-in ground-referenced headphone amplifier. An internal circuit newly developed 32-bit digital filters for better sound quality, achieving low distortion characteristics and wide dynamic range. The sampling frequency supports up to 384 kHz. The AK4376A is available in a 36-pin CSP package, utilizing less board space than competitive offerings.



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4. Block Diagram and Functions

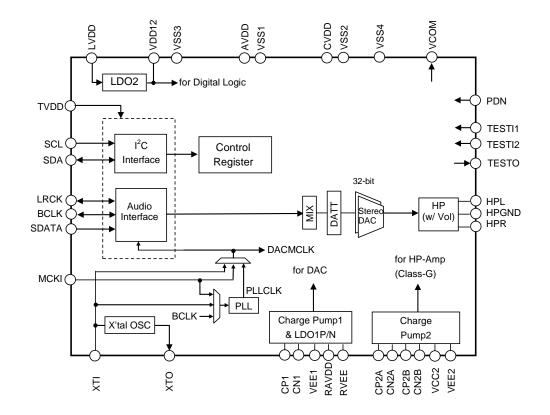
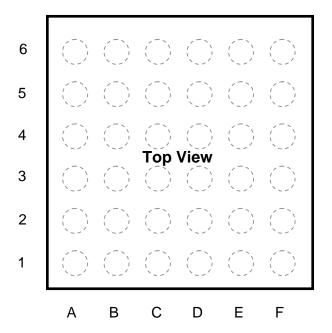


Figure 1. Block Diagram

5. Pin Configurations and Functions

■ Pin Configurations

36-pin CSP (2.74 x 2.56 mm, 0.4 mm pitch)



<u> </u>	A	В	С	D	E	F
1	XTI	RAVDD	RVEE	AVDD	VCOM	HPL
2	ХТО	SCL	VSS4	VSS1	HPGND	HPR
3	MCKI	SDA	TESTI2	TESTO	VCC2	VEE2
4	BCLK	TVDD	TESTI1	VSS2	CP2A	CN2A
5	VSS3	LRCK	PDN	CP1	CP2B	CN2B
6	VDD12	SDATA	LVDD	VEE1	CN1	CVDD

Top View

Pin Functions

No.	Pin Name	I/O	Function	Protection Diode	Power Domain
Powe	Power Supply				
D1	AVDD	-	Analog Power Supply Pin		AVDD
D2	VSS1	-	Analog Ground Pin		
F6	CVDD	-	HP-Amp/Charge Pump Power Supply Pin		CVDD
D4	VSS2	-	HP-Amp/Charge Ground Pin		
C6	LVDD	-	Digital Core & LDO2 Power Supply Pin		LVDD
A5	VSS3	-	Digital Ground Pin		
C2	VSS4	-	Substrate Pin		
B4	TVDD	-	Digital I/F Power Supply Pin		TVDD
E1	VCOM	0	Common Voltage Output Pin This pin must be connected to the VSS1 pin with a 10 μ F ±50% Ceramic capacitor in series.	AVDD/ VSS1	
A6	VDD12	-	LDO2 (1.2 V) Output Power Supply Pin (Note 1) This pin must be connected to the VSS3 pin with a capacitor in series.	LVDD/ VSS1	LVDD

Note 1. Capacitor value for the VDD12 pin should be selected from 2.2 μ F±50% to 4.7 μ F±50%. Note 2. Do not connect a load to VCOM pin and VDD12 pin.

No.	Pin Name	I/O	Function	Protection	Power
Charo	je Pump & L			Diode	Domain
E3	VCC2	0	Charge Pump Circuit Positive Voltage Output Pin (CVDD or 1/2*CVDD) This pin must be connected to the VSS2 pin with a $2.2 \ \mu F \pm 50\%$ capacitor in series.	CVDD/ VSS2	CVDD
E4	CP2A	0	Positive Charge-Pump Capacitor Terminal 2A Pin This pin must be connected to the CN2A pin with a 2.2 μ F ±50% capacitor in series.	CVDD/ VSS2	CVDD
F4	CN2A	I	Negative Charge Pump Capacitor Terminal 2A Pin This pin must be connected to the CP2A pin with a 2.2 μ F ±50% capacitor in series.	CVDD	CVDD
E5	CP2B	0	Positive Charge Pump Capacitor Terminal 2B Pin This pin must be connected to the CN2B pin with a $2.2 \ \mu F \pm 50\%$ capacitor in series.	CVDD/ VSS2	CVDD
F5	CN2B	I	Negative Charge Pump Capacitor Terminal 2B Pin This pin must be connected to the CP2B pin with a $2.2 \ \mu F \pm 50\%$ capacitor in series.	CVDD	CVDD
F3	VEE2	0	Charge Pump Circuit Negative Voltage (–CVDD or –1/2*CVDD) Output 2 Pin This pin must be connected to the VSS2 pin with a $2.2 \ \mu F \pm 50\%$ capacitor in series.	CVDD/ VSS2	
D5	CP1	0	Positive Charge Pump Capacitor Terminal 1 Pin This pin must be connected to the CN1 pin with a 1 μ F ±50% capacitor in series.	CVDD/ VSS2	CVDD
E6	CN1	I	Negative Charge Pump Capacitor Terminal 1 Pin This pin must be connected to the CP1 pin with a 1 μ F ±50% capacitor in series.	CVDD	CVDD
D6	VEE1	ο	Charge Pump Circuit Negative Voltage (–CVDD) Output 1 Pin This pin must be connected to the VSS2 pin with a 1 μ F \pm 50% capacitor in series.	CVDD/ VSS2	
B1	RAVDD	0	LDO1P (1.5V) Output Pin (Note 3) This pin must be connected to the VSS1 pin with a capacitor in series.	AVDD/ VSS1	
C1	RVEE	0	LDO1N (–1.5V) Output Pin (Note 3) This pin must be connected to the VSS1 pin with a capacitor in series.	AVDD/ VSS1	

Note 3. Capacitor values for the RAVDD pin and RVEE pin should be selected from 1 μ F±50% to 4.7 μ F±50%.

Note 4. Do not connect a load to VEE1 pin, VCC2 pin, VEE2 pin, RAVDD pin and RVEE pin.

No.	Pin Name	I/O	Function	Protection Diode	Power Domain
Contr	ol Interface				
B2	SCL	I	I ² C Serial Data Clock Pin	TVDD/ VSS3	TVDD
B3	SDA	I/O	I ² C Serial Data Input/Output Pin	TVDD/ VSS3	TVDD
Audio	Interface				
A3	MCKI	I	External Master Clock Input Pin	TVDD/ VSS3	TVDD
A1	ХТІ	I	X'tal Oscillator Input Pin	AVDD/ VSS1	AVDD
A2	хто	0	X'tal Oscillator Output Pin	AVDD/ VSS1	AVDD
A4	BCLK	I/O	Audio Serial Data Clock Pin	TVDD/ VSS3	TVDD
B5	LRCK	I/O	Frame Sync Clock Pin	TVDD/ VSS3	TVDD
B6	SDATA	I	Audio Serial Data Input Pin	TVDD/ VSS3	TVDD
Analo	g Output				
F1	HPL	0	Lch Headphone-Amp Output Pin	CVDD/ VEE2	CVDD/ VEE2
F2	HPR	0	Rch Headphone-Amp Output Pin	CVDD/ VEE2	CVDD/ VEE2
E2	HPGND	I	Headphone-Amp Ground Loop Noise Cancellation Pin	-	-
Other	S				
C5	PDN	I	Power down Pin "L": Power-down, "H": Power-up	TVDD/ VSS3	TVDD
C4	TESTI1	I	Test Input Pin It must be tied "L".	TVDD/ VSS3	TVDD
D3	TESTO	0	Test Output Pin	AVDD/ VSS1	AVDD
C3	TESTI2	I	Test Input Pin It must be tied "L".	TVDD/ VSS3	TVDD

Note 5. All input pins except analog input pin must not be allowed to float. I/O pin should be connected appropriately.

Handing of Unused Pins

Unused I/O pins must be connected appropriately.

Classification	Pin Name	Setting
Analog	HPL, HPR, XTO	Open
Analog	XTI	Open (PMOSC bit is fixed to "0")
Digital	TESTO	Open
Digital	MCKI, TESTI1, TESTI2	Connect to VSS3

6. Absolute Maximum Ratings

(VSS1 = VSS2 = VSS3 = VSS4 = 0 V; Note 7, Note 8
--

Parameter		Symbol	Min.	Max.	Unit
Power	Analog	AVDD	-0.3	4.3	V
Supplies:	HP-Amp/Charge Pump	CVDD	-0.3	4.3	V
(Note 6)	LDO2 for Digital Core	LVDD	-0.3	4.3	V
	Digital I/F	TVDD	-0.3	4.3	V
Input Current	, Any Pin Except Supplies	IIN	-	±10	mA
Analog Input	Voltage (Note 9)	VINA	-0.3	AVDD+0.3 or 4.3	V
Digital Input Voltage (Note 10)		VIND	-0.3	TVDD+0.3 or 4.3	V
Ambient Terr	perature (powered applied)	Та	-40	85	°C
Storage Tem	perature	Tstg	-65	150	°C

Note 6. Charge pump 1 & 2 are not in operation. In the case that charge pump 1 & 2 are in operation, the maximum values of AVDD and CVDD become 2.15 V.

Note 7. All voltages with respect to ground.

Note 8. VSS1, VSS2, VSS3 and VSS4 must be connected to the same analog plane. Note 9. XTI pin

The maximum value of input voltage is lower value between (AVDD+0.3)V and 4.3V.

Note 10. MCKI, BCLK, LRCK, SDATA, SCL, SDA, PDN, TESTI1, TESTI2 pins

The maximum value of input voltage is lower value between (TVDD+0.3)V and 4.3V.

WARNING: Operation at or beyond these limits may result in permanent damage to the device. Normal Operation is not guranteed at these extremes.

	7. Recommended Operating Conditions								
(VSS1 = VS	(VSS1 = VSS2 = VSS3 = VSS4 = 0 V; Note 11)								
Parameter	Parameter Symbol Min. Typ. Max. Unit								
Power	Analog	AVDD	1.7	1.8	1.9	V			
supplies	HP-Amp / Charge Pump	CVDD	1.7	1.8	1.9	V			
(Note 12)	LDO2 for Digital Core	LVDD	1.7	1.8	1.9	V			
	Digital I/F	TVDD	1.65	1.8	3.6	V			

Note 11. All voltages with respect to ground.

Note 12. Each power up/down sequence is shown below.

- <Power-up>
- 1. PDN pin = "L"

 TVDD, AVDD, LVDD, CVDD (AVDD must be powered up before or at the same time of CVDD. The power-up sequence of TVDD and LVDD is not critical.)

3. The PDN pin is allowed to be "H" after all power supplies are applied and settled.

<Power-down>

- 1. PDN pin = "L"
- 2. TVDD, AVDD, LVDD, CVDD

(CVDD must be powered down before or at the same time of AVDD. The power-down sequence of TVDD and LVDD is not critical.)

8. Electrical Characteristics

Analog Characteristics

(Ta = 25° C; AVDD = CVDD = LVDD = TVDD = 1.8 V; VSS1 = VSS2 = VSS3 = VSS4 = HPGND = 0 V; Signal Frequency = 1 kHz; 24-bit Data; fs = 44.1 kHz, BCLK = 64 fs; Measurement Bandwidth = 20 Hz to 20 kHz; unless otherwise specified)

<High Performance Mode> Parameter Min. Max. Unit Typ. **Stereo DAC Characteristics:** Resolution -32 Bit -Headphone-Amp Characteristics: DAC (Stereo) \rightarrow HPL/HPR pins, OVL/R = 0 dB, HPG = 0 dB, R_L = 32 Ω Output Power $0 \text{ dBFS}, \text{R}_{\text{L}} = 32\Omega, \text{HPG} = 0 \text{ dB},$ 25 mW THD+N < -60 dB0 dBFS, $R_L = 32\Omega$, HPG = -4 dB -10 mW $0 \text{ dBFS}, \text{R}_{\text{I}} = 16\Omega, \text{HPG} = 0 \text{ dB},$ 45 mW --THD+N < -60 dB $-1.5 \text{ dBFS}, \text{R}_{\text{I}} = 16\Omega, \text{HPG} = +2 \text{ dB},$ 60 mW _ _ THD+N < -20 dBOutput Level (0 dBFS, $R_L = 32\Omega$, HPG = -4 dB) 0.52 0.57 0.61 Vrms THD+N $0 \text{ dBFS}, \text{R}_{\text{I}} = 32\Omega, \text{OVL/R} = -4 \text{ dB},$ fs = 44.1 kHz_ -107 _ dB HPG = 0 dB (Po = 10 mW)BW = 20 kHzfs = 96 kHzdB -103 _ -BW = 40 kHzfs = 192 kHzdB -103 _ BW = 40 kHzfin = 10kHzfs = 44.1 kHzdB -104-_ BW = 20kHz $0 \text{ dBFS}, \text{R}_1 = 32\Omega, \text{OVL/R} = -10 \text{ dB},$ fs = 44.1 kHz_ -100-90 dB BW = 20 kHzHPG = 0 dB (Po = 2.5 mW) $0 \text{ dBFS}, \text{R}_1 = 16\Omega, \text{OVL/R} = -4 \text{ dB},$ fs = 44.1 kHz-106 dB _ _ HPG = 0 dB (Po = 20 mW)BW = 20 kHz $-4 \text{ dBFS}, R_1 = 600\Omega, HPG = +6 \text{ dB},$ fs = 44.1 kHz-99 dB (Po = 2.0 mW @ 1.1Vrms) BW = 20 kHz

Parameter	Min.	Тур.	Max.	Unit
Dynamic Range	100	110		dD
-60 dBFS, A-weighted, HPG = 0 dB	108	116	-	dB
S/N (A-weighted, Noise Gate Enable)		125		dB
Po = 25 mW, HPG = 0 dB (Data = 0 dBFS / "0" Data)	-	125	-	uБ
S/N (A-weighted, Noise Gate Disable)	108	116		dB
Po = 25 mW, HPG = 0 dB (Data = 0 dBFS / "0" Data)	100	110	_	UD
Output Noise Level	_	-126	_	dBV
(Noise Gate Enable, A-weighted)		-120		uD v
Output Noise Level	_	-125	_	dBV
(Noise Gate Disable, A-weighted, HPG \leq -14 dB)		120		ab v
Interchannel Isolation				
0 dBFS, HPG = -4 dB (Po = 10 mW)				
External Impedance = 0.01Ω (Note 13)	80	100	-	dB
External Impedance = 0.1Ω (Note 13)	-	80	-	dB
Interchannel Gain Mismatch	-	0	0.8	dB
Load Resistance	14.4	32	-	Ω
Load Capacitance	-	-	1000	pF
Load Inductance	-	-	0.375	μH
PSRR (HPG = -4 dB) (Note 14)				
217 Hz	-	85	-	dB
1 kHz	-	85	-	dB
DC-offset (Note 15)				
HPG = 0 dB	-0.25	0	+0.25	mV
HPG = All Gain	-0.4	0	+0.4	mV
Headphone Output Volume Characteristics:				
Gain Setting	-20	-	+6	dB
Step Width Gain: +6 to -20 dB	1	2	3	dB

Note 13. Impedance between the HPGND pin and the system ground. Note 14. PSRR is referred to all power supplies with 100 mVpp sine wave.

Note 15. When there is no gain change and temperature drift after HP-Amp is powered up.

Parameter	Value	Unit
ESD Immunity IEC61000-4-2 Level4, Contact (Note 16)	±8	kV

Note 16. It is measured at the HPL and HPR pins on an evaluation board (AKD4376A-SC Rev.1).

<Low Power Mode>

Parameter		Min.	Тур.	Max.	Unit
Headphone-Amp Characteristics:					
DAC(Stereo) \rightarrow HPL/HPR pins, OVL/F	R = 0 dB, HPG	$= 0 \text{ dB}, \text{ R}_{L}$	= 32Ω		
Output Power					
0 dBFS, $R_L = 32\Omega$, HPG = 0 dB,			25	_	mW
THD+N < -60 dB			23	-	11100
0 dBFS, $R_L = 32\Omega$, HPG = -4 dB		-	10	-	mW
0 dBFS, $R_L = 16\Omega$, HPG = 0 dB,		_	45	_	mW
THD+N < -60 dB			45	_	11100
$-1.5 \text{ dBFS}, \text{ R}_{\text{L}} = 16\Omega, \text{ HPG} = +2 \text{ dB},$		_	60	_	mW
THD+N < -20 dB			00		11100
Output Level (0 dBFS, $R_L = 32\Omega$, HPG =	–4 dB)	0.52	0.57	0.61	Vrms
T <u>HD+N</u>				•	
	s = 44.1 kHz	_	-92	_	dB
	3W = 20 kHz		-92		чъ
	s = 44.1 kHz	-	-92	-	dB
	3W = 20 kHz		52		u.D
, E ,	s = 44.1 kHz	-	-98	-	dB
	3W = 20 kHz				
Dynamic Range		-	113	-	dB
(-60 dBFS, A-weighted, HPG = 0 dB, Data	ata = 0 dBFS)		-		
S/N (A-weighted)	·	-	113	-	dB
Po = 25 mW, HPG = 0 dB (Data = 0 dBF Interchannel Isolation	S/ U Dala)				
0 dBFS, HPG = -4 dB (Po = 10 mW)					
External Impedance = 0.01Ω (Note 17)		80	100	_	dB
External Impedance = $0.0 \Omega_2$ (Note 17) External Impedance = 0.1Ω (Note 17))	-	80	-	dB
Interchannel Gain Mismatch		-	0	0.8	dB
Load Resistance		14.4	32	-	Ω
Load Capacitance		-	-	1000	pF
Load Inductance		-	_	0.375	μΗ
PSRR (HPG = -4 dB) (Note 18)					
217 Hz		-	85	-	dB
1 kHz		-	85	-	dB
DC-offset (Note 19)					
HPG = 0 dB		-0.35	0	+0.35	mV
HPG = All Gain		-0.5	0	+0.5	mV
Headphone Output Volume Character	istics:		-		
Gain Setting		-20	-	+6	dB
Step Width Gain: +6 to -2	0 dB	1	2	3	dB
		•		÷	

Note 17. Impedance between the HPGND pin and the system ground.

Note 18. PSRR is referred to all power supplies with 100 mVpp sine wave.

Note 19. When there is no gain change and temperature drift after HP-Amp is powered up.

PLL Characteristics

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; unless otherwise specified)

Parameter	Min.	Тур.	Max.	Unit
PLL Characteristics			•	
Reference Clock (Figure 11)	0.256	-	3.072	MHz
Output Frequency (PLLCLK) (Figure 11)				
44.1 kHz * 256fs * 9	-	101.606	-	MHz
48.0 kHz * 256fs * 9	-	110.592	-	MHz
44.1 kHz * 256fs * 10	-	112.896	-	MHz
48.0 kHz * 256fs * 10	-	122.880	-	MHz
Lock Time	-	-	2	ms

■ Charge Pump & LDO Circuit Power-up Time

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; unless otherwise specified)

Parameter	Capacitor	Min.	Тур.	Max.	Unit
Block power up time					
CP1 (Note 20)	1 μF @ VEE1	-	-	6.5	ms
CP2 (Class-G) (Note 20, Note 21)	2.2 μF @ VEE2	-	-	4.5	ms
LDO1P (Note 22)	1 μF @ RAVDD	-	-	1	ms
LDO1N (Note 22)	1μF @ RVEE	-	-	1	ms
LDO2 (Note 20)	2.2 μF @ VDD12	-	-	1	ms

Note 20. Power up time is a fixed value that is not affected by a capacitor.

Note 21. Power up time is a value to -1/2CVDD, since CP2 starts with 1/2 VDD Mode as part of Class-G operation.

Note 22. Power-up time is proportional to a capacitor value. For instance, if a 2.2 μ F capacitor is connected to the RVEE pin, LDO1N power-up time is 2.2ms (max.).

Power Supply Current

(Ta = 25°C; AVDD = CVDD = LVDD = TVDD = 1.8 V; VSS1 = VSS2 = VSS3 = VSS4 = HPGND = 0 V, BCLK = 64fs; Slave Mode, No Data input, $R_L = 32\Omega$; unless otherwise specified)

Parameter	Min.	Тур.	Max.	Unit
Power Supply Current:				
Power Up (PDN pin = "H", All Circuits Power-up) (Note	23)			
AVDD+ CVDD + LVDD + TVDD	-	23	-	mA
Power Up (PDN pin = "H", DAC+HP-amp Power-Up, Pl	LL & X'tal OS	C Power Dov	vn) (<mark>Note 2</mark> 4	4)
AVDD+ CVDD + LVDD + TVDD	-	20	30	mA
Power Down (PDN pin = "L")				
AVDD + CVDD + LVDD + TVDD	-	0	10	μA

Note 23. DAC, HP-Amp, PLL and X'tal OSC are all powered up. Note 24. All digital input pins are fixed to TVDD or VSS3.

■ Power Consumptions for Each Operation Mode

(Ta = 25°C; AVDD = CVDD = LVDD = TVDD = 1.8 V; VSS1 = VSS2 = VSS3 = VSS4 = 0 V; MCKI = 256fs, BCLK = 64fs; Slave Mode, No data input, $R_L = 32\Omega$, X'tal OSC Power-down) <High Performance Mode>

	AVDD	CVDD	LVDD	TVDD	Total Power
	[mA]	[mA]	[mA]	[mA]	[mW]
$DAC \rightarrow HP (fs = 44.1 \text{ kHz})$	8.38	11.34	0.47	0.02	36.32
$DAC \rightarrow HP (fs = 96 \text{ kHz})$	8.38	11.34	0.57	0.02	36.55
$DAC \rightarrow HP (fs = 192 \text{ kHz})$	8.38	11.34	0.62	0.02	36.64

<Low Power Mode>

	AVDD	CVDD	LVDD	TVDD	Total Power
	[mA]	[mA]	[mA]	[mA]	[mW]
$DAC \rightarrow HP (fs = 44.1 \text{ kHz})$	3.23	4.03	0.36	0.02	13.75

■ DAC Sharp Roll-Off Filter (fs = 44.1 kHz)

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; fs = 44.1 kHz; DASD bit = "0", DASL bit = "0")

Parameter	Symbol	Min.	Тур.	Max.	Unit			
DAC Digital Filter(LPF):								
Passband -0.006 to +0.124 dB	PB	0	-	20.42	kHz			
(Note 25) –6.0 dB		-	22.05	-	kHz			
Stopband (Note 25)	SB	24.1	-	-	kHz			
Passband Ripple	PR	-0.006	-	+0.124	dB			
Stopband Attenuation (Note 26)	SA	69.9	-	-	dB			
Group Delay (Note 27)	GD	-	26	-	1/fs			
DAC Digital Filter (LPF) + DACANA (H	leadphone	-Amp) @ Hig	h performar	nce mode :				
Frequency Response: 0 to 20.0 kHz	FR	-0.12	-	+0.03	dB			
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ Low power mode :								
Frequency Response: 0 to 20.0 kHz	FR	-0.68	-	+0.03	dB			

Note 25. The passband and stopband frequencies scale with fs (system sampling rate).

PB = 0.4630 x fs (@-0.006 /+0.124 dB), SB = 0.5465 x fs. Each frequency response refers to that of 1 kHz.

Note 26. The bandwidth of the stopband attenuation value is from stopband to fs (system sampling rate).

Note 27. The calculated delay time is resulting from digital filtering. This is the time from the input of MSB for Lch of SDATA to the output of an analog signal. The error of the delay at audio interface is within +1 [1/fs].

■ DAC Sharp Roll-Off Filter (fs = 96 kHz)

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; fs = 96 kHz; DASD bit = "0", DASL bit = "0")

Parameter		Symbol	Min.	Тур.	Max.	Unit			
DAC Digital	DAC Digital Filter(LPF):								
Passband	-0.003 to +0.127 dB	PB	0	-	44.4	kHz			
(Note 28)	–6.0 dB		-	48.01	-	kHz			
Stopband (N	ote 28)	SB	52.5	-	-	kHz			
Passband Ripple		PR	-0.003	-	+0.127	dB			
Stopband Att	enuation (Note 29)	SA	69.9	-	-	dB			
Group Delay	(Note 30)	GD	-	26	-	1/fs			
DAC Digital	Filter (LPF) + DACANA (H	leadphone	-Amp) @ Hig	h performar	nce mode :				
Frequency R	esponse: 0 to 40.0 kHz	FR	-0.72	-	+0.11	dB			
DAC Digital	Filter (LPF) + DACANA (H	leadphone	-Amp) @ Lov	w power moo	de :				
Frequency R	esponse: 0 to 40.0 kHz	FR	-2.18	-	+0.10	dB			

Note 28. The passband and stopband frequencies scale with fs (system sampling rate).

PB = 0.4625 x fs (@-0.003/+0.127 dB), SB = 0.547 x fs. Each frequency response refers to that of 1 kHz.

Note 29. The bandwidth of the stopband attenuation value is from stopband to fs (system sampling rate).

Note 30. The calculated delay time is resulting from digital filtering. This is the time from the input of MSB for Lch of SDATA to the output of an analog signal. The error of the delay at audio interface is within +1 [1/fs].

■ DAC Sharp Roll-Off Filter (fs = 192 kHz)

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; fs = 192 kHz; DASD bit = "0", DASL bit = "0")

Parameter	·	Symbol	Min.	Тур.	Max.	Unit		
DAC Digital Filter(LPF):								
Passband	-0.002 to +0.13 dB	PB	0	-	88.94	kHz		
(Note 31)	–6.0 dB		-	96.01	-	kHz		
Stopband (Note	e 31)	SB	105	-	-	kHz		
Passband Ripple		PR	-0.002	-	+0.13	dB		
Stopband Atten	uation (Note 32)	SA	69.9	-	-	dB		
Group Delay (N	lote 33)	GD	-	26	-	1/fs		
DAC Digital Fi	lter (LPF) + DACANA (F	leadphone-	-Amp) @ Hig	h performar	nce mode :			
Frequency Res	ponse: 0 to 80.0 kHz	FR	-2.90	-	+0.35	dB		
DAC Digital Fil	DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ Low power mode :							
Frequency Res	ponse: 0 to 80.0 kHz	FR	-6.42	-	+0.35	dB		

Note 31. The passband and stopband frequencies scale with fs (system sampling rate).

PB = 0.4538 x fs (@-0.002/+0.13 dB), SB = 0.5469 x fs. Each frequency response refers to that of 1 kHz.

Note 32. The bandwidth of the stopband attenuation value is from stopband to fs (system sampling rate).

Note 33. The calculated delay time is resulting from digital filtering. This is the time from the input of MSB for Lch of SDATA to the output of an analog signal. The error of the delay at audio interface is within +1 [1/fs].

■ DAC Slow Roll-Off Filter (fs = 44.1 kHz)

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; fs = 44.1 kHz; DASD bit = "0", DASL bit = "1")

Parameter	Symbol	Min.	Тур.	Max.	Unit				
DAC Digital Filter(LPF):									
Passband -0.07 to +0.006 dB	PB	0	-	7.7	kHz				
(Note 34) –3.0 dB		-	18.34	-	kHz				
Stopband (Note 34)	SB	39.1	-	-	kHz				
Passband Ripple	PR	-0.07	-	+0.006	dB				
Stopband Attenuation (Note 35)	SA	72.8	-	-	dB				
Group Delay (Note 36)	GD	-	26	-	1/fs				
DAC Digital Filter (LPF) + DACANA (I	leadphone	-Amp) @ Hig	gh performa	nce mode :					
Frequency Response: 0 to 20.0 kHz	FR	-4.44	-	+0.03	dB				
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ Low power mode :									
Frequency Response: 0 to 20.0 kHz	FR	-5.00	-	+0.03	dB				

Note 34. The passband and stopband frequencies scale with fs (system sampling rate).

PB = $0.1746 \times \text{fs} (@-0.07/+0.006 \text{ dB})$, SB = $0.887 \times \text{fs}$. Each frequency response refers to that of 1 kHz.

Note 35. The bandwidth of the stopband attenuation value is from stopband to fs (system sampling rate).

Note 36. The calculated delay time is resulting from digital filtering. This is the time from the input of MSB for Lch of SDATA to the output of an analog signal. The error of the delay at audio interface is within +1 [1/fs].

■ DAC Slow Roll-Off Filter (fs = 96 kHz)

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; fs = 96 kHz; DASD bit = "0", DASL bit = "1")

Parameter	Symbol	Min.	Тур.	Max.	Unit			
DAC Digital Filter (LPF):								
Passband0.07 to +0.007 dB	PB	0	-	16.76	kHz			
(Note 37) –3.0 dB		-	39.9	-	kHz			
Stopband (Note 37)	SB	85.2	-	-	kHz			
Passband Ripple	PR	-0.07	-	+0.007	dB			
Stopband Attenuation (Note 38)	SA	72.8	-	-	dB			
Group Delay (Note 39)	GD	-	26	-	1/fs			
DAC Digital Filter (LPF) + DACANA (H	leadphone [,]	-Amp) @ Hig	h performar	nce mode:				
Frequency Response: 0 to 40.0 kHz	FR	-4.00	-	+0.10	dB			
DAC Digital Filter (LPF) + DACANA (H	DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ Low power mode:							
Frequency Response: 0 to 40.0 kHz	FR	-5.46	-	+0.10	dB			

Note 37. The passband and stopband frequencies scale with fs (system sampling rate).

PB = $0.1746 \times \text{fs} (@-0.07/+0.007 \text{ dB})$, SB = $0.887 \times \text{fs}$. Each frequency response refers to that of 1 kHz.

Note 38. The bandwidth of the stopband attenuation value is from stopband to fs (system sampling rate).

Note 39. The calculated delay time is resulting from digital filtering. This is the time from the input of MSB for Lch of SDATA to the output of an analog signal. The error of the delay at audio interface is within +1 [1/fs].

■ DAC Slow Roll-Off Filter (fs = 192 kHz)

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; fs = 192 kHz; DASD bit = "0", DASL bit = "1")

Parameter	·	Symbol	Min.	Тур.	Max.	Unit		
DAC Digital	DAC Digital Filter (LPF):							
Passband	-0.07 to +0.007 dB	PB	0	-	33.56	kHz		
(Note 40)	–3.0 dB		-	79.9	-	kHz		
Stopband (N	ote 40)	SB	170.3	-	-	kHz		
Passband Ri	Passband Ripple		-0.07	-	+0.007	dB		
Stopband At	tenuation (Note 41)	SA	72.8	-	-	dB		
Group Delay	(Note 42)	GD	-	26	-	1/fs		
DAC Digital	Filter (LPF) + DACANA (H	leadphone	-Amp) @ Hig	h performar	nce mode :			
Frequency R	esponse: 0 to 80.0 kHz	FR	-6.00	-	+0.35	dB		
DAC Digital	Filter (LPF) + DACANA (H	leadphone	-Amp) @ Lov	w power mod	de :			
Frequency R	esponse: 0 to 80.0 kHz	FR	-9.47	-	+0.35	dB		

Note 40. The passband and stopband frequencies scale with fs (system sampling rate).

PB = $0.1748 \times \text{fs} (@-0.07/+0.007 \text{ dB})$, SB = $0.887 \times \text{fs}$. Each frequency response refers to that of 1 kHz.

Note 41. The bandwidth of the stopband attenuation value is from stopband to fs (system sampling rate).

Note 42. The calculated delay time is resulting from digital filtering. This is the time from the input of MSB for Lch of SDATA to the output of an analog signal. The error of the delay at audio interface is within +1 [1/fs].

■ DAC Short Delay Sharp Roll-Off Filter (fs = 44.1 kHz)

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; fs = 44.1 kHz; DASD bit = "1", DASL bit = "0")

Parameter		Symbol	Min.	Тур.	Max.	Unit				
DAC Digital F	DAC Digital Filter (LPF):									
Passband	–0.008 to +0.126 dB	PB	0	-	20.4	kHz				
(Note 43)	–6.0 dB		-	22.18	-	kHz				
Stopband (Not	te 43)	SB	24.1	-	-	kHz				
Passband Rip	ple	PR	-0.008	-	+0.126	dB				
Stopband Atte	enuation (Note 44)	SA	56.4	-	-	dB				
Group Delay (Note 45)		GD	-	5.5	-	1/fs				
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ High performance mode :										
Frequency Response: 0 to 20.0 kHz		FR	-0.12	-	+0.03	dB				
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ Low power mode :										
Frequency Re	sponse: 0 to 20.0 kHz	FR	-0.68	-	+0.03	dB				

Note 43. The passband and stopband frequencies scale with fs (system sampling rate).

PB = $0.4626 \times \text{fs}$ (@-0.008/+0.126 dB), SB = $0.5465 \times \text{fs}$. Each frequency response refers to that of 1 kHz.

Note 44. The bandwidth of the stopband attenuation value is from stopband to fs (system sampling rate).

Note 45. The calculated delay time is resulting from digital filtering. This is the time from the input of MSB for Lch of SDATA to the output of an analog signal. The error of the delay at audio interface is within +1 [1/fs].

■ DAC Short Delay Sharp Roll-Off Filter (fs = 96 kHz)

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; fs = 96 kHz; DASD bit = "1", DASL bit = "0")

Parameter	Symbol	Min.	Тур.	Max.	Unit		
DAC Digital Filter (LPF):							
Passband -0.003 to +0.132dB	PB	0	-	44.4	kHz		
(Note 46) –6.0 dB		-	48.28	-	kHz		
Stopband (Note 46)	SB	52.5	-	-	kHz		
Passband Ripple	PR	-0.003	-	+0.132	dB		
Stopband Attenuation (Note 47)	SA	56.4	-	-	dB		
Group Delay (Note 48)	GD	-	5.5	-	1/fs		
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ High performance mode:							
Frequency Response: 0 to 40.0 kHz	FR	-0.90	-	+0.11	dB		
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ Low power mode:							
Frequency Response: 0 to 40.0 kHz	FR	-2.36	-	+0.10	dB		

Note 46. The passband and stopband frequencies scale with fs (system sampling rate).

PB = $0.4625 \times \text{fs} (@-0.003/+0.132 \text{ dB})$, SB = $0.5465 \times \text{fs}$. Each frequency response refers to that of 1 kHz.

Note 47. The bandwidth of the stopband attenuation value is from stopband to fs (system sampling rate).

Note 48. The calculated delay time is resulting from digital filtering. This is the time from the input of MSB for Lch of SDATA to the output of an analog signal. The error of the delay at audio interface is within +1 [1/fs].

■ DAC Short Delay Sharp Roll-Off Filter (fs = 192 kHz)

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; fs = 192 kHz; DASD bit = "1", DASL bit = "0")

Parameter	Symbol	Min.	Тур.	Max.	Unit		
DAC Digital Filter (LPF):							
Passband -0.001 to +0.135 dB	PB	0	-	88.8	kHz		
(Note 49) –6.0 dB		-	96.57	-	kHz		
Stopband (Note 49)	SB	105	-	-	kHz		
Passband Ripple	PR	-0.001	-	+0.135	dB		
Stopband Attenuation (Note 50)	SA	56.4	-	-	dB		
Group Delay (Note 51)	GD	-	5.5	-	1/fs		
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ High performance mode :							
Frequency Response: 0 to 80.0 kHz	FR	-3.00	-	+0.36	dB		
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ Low power mode :							
Frequency Response: 0 to 80.0 kHz	FR	-6.52	-	+0.35	dB		

Note 49. The passband and stopband frequencies scale with fs (system sampling rate).

PB = $0.4625 \times \text{fs}$ (@-0.001/+0.135 dB), SB = $0.5469 \times \text{fs}$. Each frequency response refers to that of 1 kHz.

Note 50. The bandwidth of the stopband attenuation value is from stopband to fs (system sampling rate).

Note 51. The calculated delay time is resulting from digital filtering. This is the time from the input of MSB for Lch of SDATA to the output of an analog signal. The error of the delay at audio interface is within +1 [1/fs].

■ DAC Short Delay Slow Roll-Off Filter (fs = 44.1 kHz)

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; fs = 44.1 kHz; DASD bit = "1", DASL bit = "1")

Parameter	Symbol	Min.	Тур.	Max.	Unit		
DAC Digital Filter (LPF):							
Passband -0.07 to +0.025 dB	PB	0	-	8.83	kHz		
(Note 52) –3.0 dB		-	18.72	-	kHz		
Stopband (Note 52)	SB	39.5	-	-	kHz		
Passband Ripple	PR	-0.07	-	+0.025	dB		
Stopband Attenuation (Note 53)	SA	75.1	-	-	dB		
Group Delay (Note 54)	GD	-	4.7	-	1/fs		
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ High performance mode :							
Frequency Response: 0 to 20.0 kHz	FR	-4.16	-	+0.05	dB		
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ Low power mode :							
Frequency Response: 0 to 20.0 kHz	FR	-4.66	-	+0.03	dB		

Note 52. The passband and stopband frequencies scale with fs (system sampling rate).

PB = $0.2002 \times \text{fs}$ (@-0.07/+0.025 dB), SB = $0.8957 \times \text{fs}$. Each frequency response refers to that of 1 kHz.

Note 53. The bandwidth of the stopband attenuation value is from stopband to fs (system sampling rate).

Note 54. The calculated delay time is resulting from digital filtering. This is the time from the input of MSB for Lch of SDATA to the output of an analog signal. The error of the delay at audio interface is within +1 [1/fs].

■ DAC Short Delay Slow Roll-Off Filter (fs = 96 kHz)

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; fs = 96 kHz; DASD bit = "1", DASL bit = "1")

Parameter		Symbol	Min.	Тур.	Max.	Unit	
DAC Digital F	ilter (LPF):						
Passband	–0.07 to +0.027 dB	PB	0	-	19.29	kHz	
(Note 55)	–3.0 dB		-	40.78	-	kHz	
Stopband (Note 55)		SB	86	-	-	kHz	
Passband Ripple		PR	-0.07	-	+0.027	dB	
Stopband Attenuation (Note 56)		SA	75.1	-	-	dB	
Group Delay (Note 57)		GD	-	4.7	-	1/fs	
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ High performance mode :							
Frequency Response: 0 to 40.0 kHz		FR	-3.80	-	+0.10	dB	
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ Low power mode :							
Frequency Re	sponse: 0 to 40.0 kHz	FR	-5.26	-	+0.10	dB	

Note 55. The passband and stopband frequencies scale with fs (system sampling rate).

PB = $0.2009 \times \text{fs} (@-0.07/+0.027 \text{ dB})$, SB = $0.8958 \times \text{fs}$. Each frequency response refers to that of 1 kHz.

Note 56. The bandwidth of the stopband attenuation value is from stopband to fs (system sampling rate).

Note 57. The calculated delay time is resulting from digital filtering. This is the time from the input of MSB for Lch of SDATA to the output of an analog signal. The error of the delay at audio interface is within +1 [1/fs].

■ DAC Short Delay Slow Roll-Off Filter (fs = 192 kHz)

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; fs = 192 kHz; DASD bit = "1", DASL bit = "1")

Parameter	Symbol	Min.	Тур.	Max.	Unit		
DAC Digital Filter (LPF):							
Passband -0.07 to +0.027 dB	PB	0	-	38.63	kHz		
(Note 58) –3.0 dB		-	81.57	-	kHz		
Stopband (Note 58)	SB	172	-	-	kHz		
Passband Ripple	PR	-0.07	-	+0.027	dB		
Stopband Attenuation (Note 59)	SA	75.1	-	-	dB		
Group Delay (Note 60)	GD	-	4.7	-	1/fs		
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ High performance mode:							
Frequency Response: 0 to 80.0 kHz	FR	-5.90	-	+0.35	dB		
DAC Digital Filter (LPF) + DACANA (Headphone-Amp) @ Low power mode:							
Frequency Response: 0 to 80.0 kHz	FR	-9.38	-	+0.35	dB		

Note 58. The passband and stopband frequencies scale with fs (system sampling rate).

PB = $0.2012 \times \text{fs} (@-0.07/+0.027 \text{ dB})$, SB = $0.8958 \times \text{fs}$. Each frequency response refers to that of 1 kHz.

Note 59. The bandwidth of the stopband attenuation value is from stopband to fs (system sampling rate).

Note 60. The calculated delay time is resulting from digital filtering. This is the time from the input of MSB for Lch of SDATA to the output of an analog signal. The error of the delay at audio interface is within +1 [1/fs].

■ DC Characteristics

(Ta = -40 to 85° C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V)

Parameter	Symbol	Min.	Тур.	Max.	Unit
I/O Pins (Note 61)		•		÷	
High-Level Input Voltage					
Except for XTI pin	VIH	70 %TVDD	-	-	V
XTI pin	VIH	70 %AVDD	-	-	V
Low-Level Input Voltage					
Except for XTI pin	VIL	-	-	30 %TVDD	V
XTI pin	VIL	-	-	30 %AVDD	V
High-Level Output Voltage (lout = $-200 \ \mu$ A)	VOH	TVDD0.2	-	-	V
Low-Level Output Voltage					
Except for SDA, XTO pin, lout = 200 μ A	VOL	-	-	0.2	V
SDA pin					
2 V < TVDD ≤ 3.6 V (lout = 3 mA)	VOL	-	-	0.4	V
1.65 V \leq TVDD \leq 2 V (lout = 2 mA)	VOL	-	-	20 %TVDD	V
Input Leakage Current	lin	-5	-	+5	μA

Note 61. MCKI, BCLK, LRCK, SDATA, SCL, SDA, PDN, TESTI1, TESTO, TESTI2 pins

Switching Characteristics

(Ta = -40 to 85°C; AVDD = CVDD = LVDD = 1.7 to 1.9 V; TVDD = 1.65 to 3.6 V; C_L = 80 pF; unless otherwise specified)

Parameter		Symbol	Min.	Тур.	Max.	Unit
MCKI						
Input Frequency		fMCK	0.256	-	28.8	MHz
Pulse Width Low		tMCKL	0.4 / fMCK	-	-	ns
Pulse Width High		tMCKH	0.4 / fMCK	-	-	ns
X'tal Oscillator (XTI pin)						
Input Frequency		fMCK	11.2896	-	24.576	MHz
Audio Interface Timing						
Master Mode						
LRCK Output Timing						
Frequency	(Note 62)	fs	8	-	192	kHz
Pulse Width High		Duty	-	50	-	%
BCLK Output Timing						
Period (BCKO bit = "0")		tBCK	-	1/(64fs)	-	ns
(BCKO bit = "1")		tBCK	-	1/(32fs)	-	ns
Duty		Duty	-	50	-	%
BCLK "↓" to LRCK Edge		tBSYD	-20	-	20	ns
SDATA Hold Time		tBIDS	10	-	-	ns
SDATA Setup Time		tBIDH	10	-	-	ns
Slave Mode						
LRCK Input Timing						
Frequency		fs	8	-	384	kHz
Pulse Width High		tLRCKH	45	50	55	%
BCLK Input Timing						
Period	(Note 63)	tBCK	0.256	-	24.576 or 512fs	MHz
Pulse Width Low		tBCKL	0.4 x tBCK	-	-	ns
Pulse Width High		tBCKH	0.4 x tBCK	-	-	ns
BCLK "↑" to LRCK Edge		tBSYD	16	-	-	ns
LRCK Edge to BCLK "↑"		tSYBD	16	-	-	ns
SDATA Hold Time		tBIDS	10	-	-	ns
SDATA Setup Time		tBIDH	10	-	-	ns

Note 62. Supported sampling rates are 8 k, 11.025 k, 12 k, 16 k, 22.05 k, 24 k, 32 k, 44.1 k, 48 k, 64 k, 88.2 k, 96 k, 176.4 k and 192 kHz

Note 63. The maximum value is shorter period between "24.576 MHz" and "512fs".

Parameter	Symbol	Min.	Тур.	Max.	Unit
Control Interface Timing (I ² C Bus mode): (Note 64)					
SCL Clock Frequency	fSCL	-	-	400	kHz
Bus Free Time Between Transmissions	tBUF	1.3	-	-	μS
Start Condition Hold Time (prior to first clock pulse)	tHD:STA	0.6	-	-	μS
Clock Low Time	tLOW	1.3	-	-	μS
Clock High Time	tHIGH	0.6	-	-	μS
Setup Time for Repeated Start Condition	tSU:STA	0.6	-	-	μS
SDA Hold Time from SCL Falling (Note 65)	tHD:DAT	0	-	-	μS
SDA Setup Time from SCL Rising	tSU:DAT	0.1	-	-	μS
Rise Time of Both SDA and SCL Lines	tR	-	-	0.3	μS
Fall Time of Both SDA and SCL Lines	tF	-	-	0.3	μS
Setup Time for Stop Condition	tSU:STO	0.6	-	-	μS
Capacitive Load on Bus	Cb	-	-	400	pF
Pulse Width of Spike Noise Suppressed by Input Filter	tSP	0	-	50	ns
Power-down & Reset Timing					
PDN accept pulse width (Note 66)	tPDN	1	-	-	ms
PDN Reject Pulse Width (Note 66)	tRPD	-	-	50	ns

Note 64. I²C-bus is a registered trademark of NXP B.V.

Note 65. Data must be held long enough to bridge the 300ns-transition time of SCL.

Note 66. The AK4376A will be reset by the PDN pin = "L" for tPDN (Min.). The PDN pin must held "L" for longer period than or equal to tPDN (Min.). The AK4376A will not be reset by the "L" pulse shorter than or equal to tRPD (Max.).

■ Timing Diagram (System Clock)

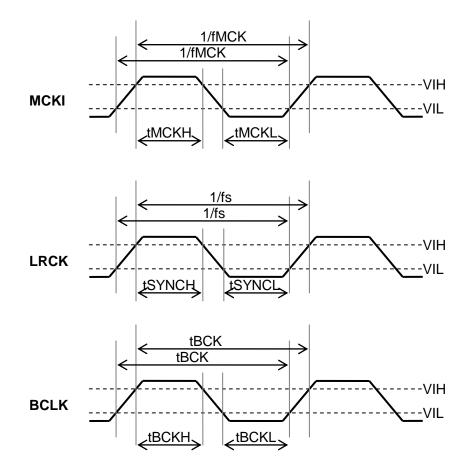


Figure 2. System Clock (Slave Mode)

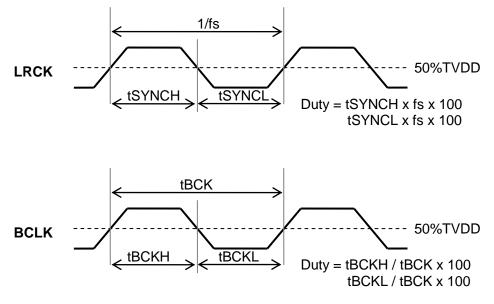
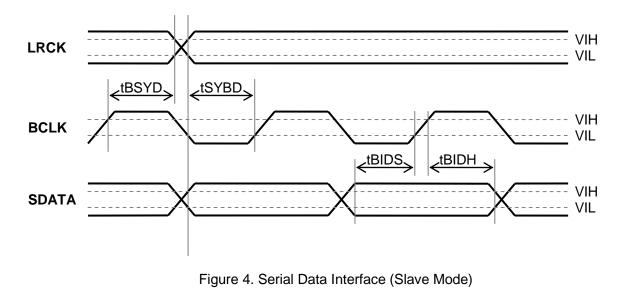


Figure 3. System Clock (Master Mode)

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■ Timing Diagram (Serial Audio I/F)

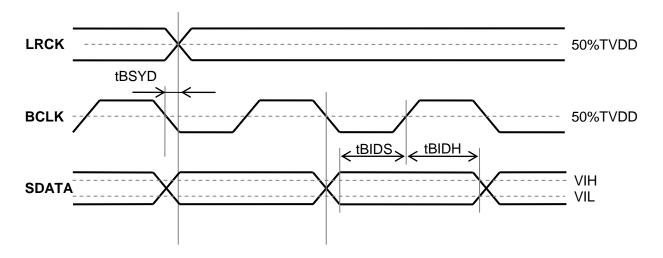
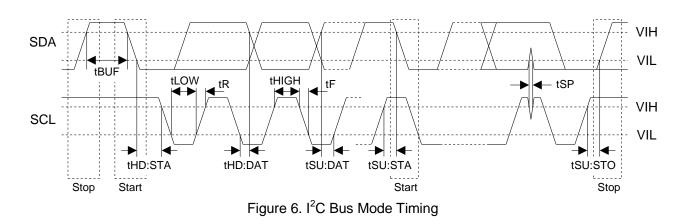
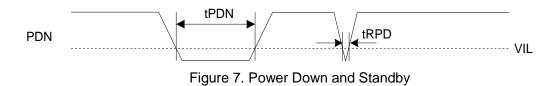


Figure 5. Serial Data Interface (Master Mode)

■ Timing Diagram (I²C Interface)



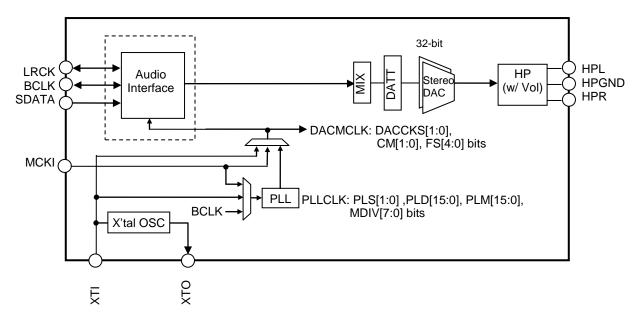
■ Timing Diagram (Reset)



9. Functional Description

System Clock

The AK4376A is operated by a clock generated by PLL or an externally input clock or X'tal oscillator (XTI pin). DACCKS[1:0] bits select the clock source of the DAC (Table 1). PLL clock source is selected from external MCKI, BCLK or the clock by X'tal oscillator (Table 7). Master clock frequency and sampling frequency are set by CM[1:0] bits and FS[4:0] bits, respectively. PMDA, PMHPL and PMHPR bits must be set to "0" when changing these frequencies.



DACCKS[1:0] bits	DAC Master Clock						
00	MCKI pin	(default)					
01	PLLCLK						
1x	X'tal (or XTI pin)						

The AK4376A can be operated in both master and slave modes. Clock mode of LRCK pin and BCLK pin can be selected by MS bit. When using master mode, the LRCK pin and the BCLK pin should be pulled down or pulled up with an external resistor (about 100 k Ω) because both pins are floating state until MS bit becomes "1".

l able 2. IV	
MS bit	
0	(default)
1	

Master/slave mode switching is not allowed while the AK4376A is in normal operation. The DAC and Headphone-Amp must be powered down before master/slave mode is switched. Furthermore PLL and Charge Pump must also be powered down in case that sampling frequency is changed or PLLCLK is stopped.

<MS bit Setting Sequence Example>

1.DAC, Headphone-Amp (PLL, Charge Pump) Power-down

2.Clock Mode of ACPU Setting (In case clock mode of ACPU is master, switch to slave.) 3.MS bit Selection

4. Clock Mode of ACPU Setting (In case clock mode of ACPU is slave, switch to master.)

5.DAC, Headphone-Amp (PLL, Charge Pump) Power-up

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Figure 9 shows clock & data flow in slave mode. Figure 10 shows clock & data flow in master mode.

```
<Salve Mode>
MS bit = "0", PMPLL bit = "0", DACCKS[1:0] bits = "00"
```

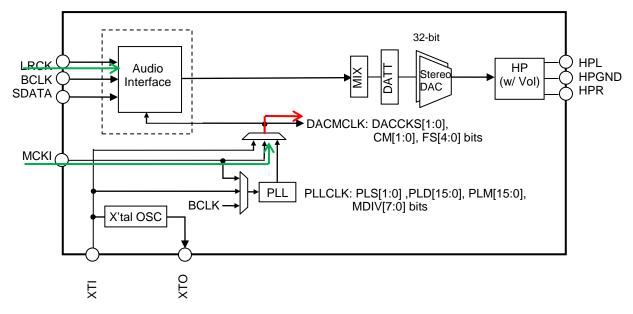


Figure 9. Example of Clock and Data Flow (Slave Mode, Not using PLL)

<Master Mode>

MS bit = "1, PMPLL bit = "1", PLS[1:0] bits = "00", DACCKS[1:0] bits = "01"

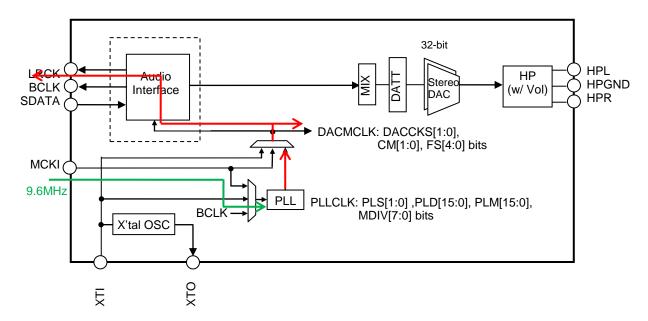


Figure 10. Example of Clock and Data Flow (Master Mode, Using PLL)

Table 3. Setting of Master Clock Trequency (Fight enormance mode)												
DSMLP bit	CM1 bit	CM0 bit	Master Clock Frequency	Sampling Frequency Range								
1	0	0	256fs	8 to 12 kHz								
0	0	0	256fs	16 to 96 kHz	(default)							
0	0	0	0	0	0	0	0	0	0	32fs	256 to 384 kHz	(uerauit)
0	0	1	512fs	8 to 48 kHz								
0	0	1	64fs	256 to 384 kHz								
0	1	0	1024fs	8 to 24 kHz								
0	1	1	128fs	128 to 192 kHz								

<High Performance Mode: LPMODE bit = "0">

Table 3. Setting of Master Clock Frequenc	v (High Performance Mode)
	y (ingri i chonnance mode)

<Low Power Mode: LPMODE bit = "1">

0	W Power Mode. LPMODE bit = 1 >									
	Table 4. Setting of Master Clock Frequency (Low Power Mode)									
	DSMLP bit	SMLP bit CM1 bit CM0 bit Master Clock Sampling Frequency								
	DSMLP bit CMT bit CM0 bit Frequency Range									
	1 0 0			256fs	8 to 96 kHz	(default)				
	1 0 1 512fs 8 to 48 kHz									
	1 1 0 1024fs 8 to 24 kHz									
	1	1	1	128fs	128 to 192 kHz					

Note 67. The AK4376A does not support Oct speed mode (fs = 256 to 384 kHz) in low power mode.

Table 5. Setting of Sampling Frequency (N/A: Not available)						
FS4 bit	FS3 bit	FS2 bit	FS1 bit	FS0 bit	Sampling Frequency	
0	0	0	0	0	8 kHz	(default)
0	0	0	0	1	11.025 kHz	
0	0	0	1	0	12 kHz	
0	0	1	0	0	16 kHz	
0	0	1	0	1	22.05 kHz	
0	0	1	1	0	24 kHz	
0	1	0	0	0	32 kHz	
0	1	0	0	1	44.1 kHz	
0	1	0	1	0	48 kHz	
0	1	1	0	0	64 kHz	
0	1	1	0	1	88.2 kHz	
0	1	1	1	0	96 kHz	
1	0	0	0	0	128 kHz	
1	0	0	0	1	176.4 kHz	
1	0	0	1	0	192 kHz	
1	0	1	0	0	256 kHz	
1	0	1	0	1	352.8 kHz	
1	0	1	1	0	384 kHz	
		Others			N/A	

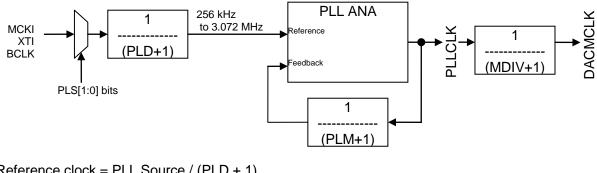
Table 5. Setting of Sampling Frequency (N/A: Not available)

* Depending on the PLL divider setting, the sampling frequency may differ. Please set PLD[15:0] and PLM[15:0] bits precisely.

■ PLL

The PLL generates a PLLCLK which is used as the DAC operation clock DACMCLK. The output frequency should be set in the range from 101.6064 to 122.88MHz (Table 6 shows setting example of 48 kHz and 44.1 kHz base rates). Refer to Table 11 to Table 12 for frequency setting examples. Reference clock of PLL should be set in the range from 256 kHz to 3.072 MHz.

Table 6. PLLCLK Setting Example							
48 kHz base rate 44.1 kHz base rate							
2560/fs	122.88 MHz	112.896 MHz					
2304/fs	110.592 MHz	101.6064 MHz					



Reference clock = PLL Source / (PLD + 1) PLLCLK = Reference clock x (PLM + 1) DACMCLK = PLLCLK / (MDIV + 1)

Figure 11. PLL Block Diagram

■ Input Clock Select Function

The PLL has a function that selects the input clock. The clock source pin is selected by PLS[1:0] bits.

Table 7.1 EL Clock Gelect (X. Do Hot care)							
PLS[1:0] bits							
00	MCKI pin	(default)					
01	BCLK pin						
1x	X'tal (XTI pin)						

Table 7. PLL Clock Select (x: Do not care)

1. PLL Reference Clock Divider

The PLL can set the dividing number of the reference clock in 16-bit. The input clock is used as PLL reference clock by dividing by (PLD+1).

Table 8. PLL Reference Clock Divider						
PLD[15:0] bits						
0000H	1	(default)				
0001H to FFFFH	1 / (PLD + 1)					

Table 8. PLL Reference Clock Divider

Note 68. The reference clock divided by PLD should be set in the range from 256 kHz to 3.072 MHz.

2. PLL Feedback Clock Divider

The dividing number of feedback clock can be set freely in 16-bit. PLLCLK is divided by (PLM +1) and used as PLL feedback clock. The feedback clock is fixed to "L" without dividing when PLM[15:0] bits = 0000H.

Table 9. PLL Feedback Clock Divider						
PLM[15:0] bits						
0000H	Clock Stop	(default)				
0001H to FFFFH	1 / (PLM + 1)					

Table 9. PLL Feedback Clock Divider

3. Power Management (PMPLL)

PLL can be powered down by a control register setting.

PMPLL bit	PLL Status						
0	Power-Down	(default)					
1	Power-Up						

4. Frequency Setting Examples

Table 11. PLL Frequency Setting Example (PLL reference source: MCKI)

CLKIN		PLL cor	ndition		PLLCLK		
Source	Frequency	D+1	REFCLK	M+1	Base Rate		-
	[Hz]		[Hz]		[Hz]	[fs]	[Hz]
MCKI	9,600,000	5	1,920,000	64	48,000	2,560	122,880,000
	19,200,000	10	1,920,000	64		2,560	122,880,000
	12,288,000	4	3,072,000	40		2,560	122,880,000
	24,576,000	8	3,072,000	40		2,560	122,880,000
	12,000,000	25	480,000	256		2,560	122,880,000
	24,000,000	25	960,000	128		2,560	122,880,000
	9,600,000	25	384,000	294	44,100	2,560	112,896,000
	19,200,000	25	768,000	147		2,560	112,896,000
	11,289,600	4	2,822,400	40		2,560	112,896,000
	22,579,200	8	2,822,400	40		2,560	112,896,000

Table 12. PLL Frequency Setting Example (PLL reference source: BCLK)

CLKIN	-	-	PLL cor	dition		PLLCLK	-	
Source	Sampling	Frequency	D+1	REFCLK	M+1	Base Rate		
	Frequency[Hz]	[Hz]		[Hz]		[Hz]	[fs]	[Hz]
BCLK	8,000	256,000	1	256,000	480	48,000	2,560	122,880,000
(32fs)	11,025	352,800	1	352,800	320	44,100	2,560	112,896,000
	16,000	512,000	1	512,000	240	48,000	2,560	122,880,000
	22,050	705,600	1	705,600	160	44,100	2,560	112,896,000
	24,000	768,000	1	768,000	160	48,000	2,560	122,880,000
	32,000	1,024,000	1	1,024,000	120	48,000	2,560	122,880,000
	44,100	1,411,200	1	1,411,200	80	44,100	2,560	112,896,000
	48,000	1,536,000	1	1,536,000	80	48,000	2,560	122,880,000
BCLK	8,000	384,000	1	384,000	320	48,000	2,560	122,880,000
(48fs)	11,025	529,200	1	529,200	192	44,100	2,304	101,606,400
	16,000	768,000	1	768,000	160	48,000	2,560	122,880,000
	22,050	1,058,400	3	352,800	320	44,100	2,560	112,896,000
	24,000	1,152,000	3	384,000	320	48,000	2,560	122,880,000
	32,000	1,536,000	1	1,536,000	80	48,000	2,560	122,880,000
	44,100	2,116,800	3	705,600	160	44,100	2,560	112,896,000
	48,000	2,304,000	3	768,000	160	48,000	2,560	122,880,000
BCLK	8,000	512,000	1	512,000	240	48,000	2,560	122,880,000
(64fs)	11,025	705,600	1	705,600	160	44,100	2,560	112,896,000
	16,000	1,024,000	1	1,024,000	120	48,000	2,560	122,880,000
	22,050	1,411,200	1	1,411,200	80	44,100	2,560	112,896,000
	24,000	1,536,000	1	1,536,000	80	48,000	2,560	122,880,000
	32,000	2,048,000	1	2,048,000	60	48,000	2,560	122,880,000
	44,100	2,822,400	1	2,822,400	40	44,100	2,560	112,896,000
	48,000	3,072,000	1	3,072,000	40	48,000	2,560	122,880,000

DACMCLK Generating Divider Setting

MDIV[7:0] bits control DACMCLK divider.

Table 13. DACMCLK Divider Setting						
MDIV[7:0] bits	Dividing Number					
00H	1	(default)				
01H to FFH	1 / (MDIV + 1)					

Crystal Oscillator

The clock for the XTI pin can be generated by two methods. PMOSC bit must be set to "1" when using a crystal oscillator.

1) X'tal Mode (PMOSC bit = "1")

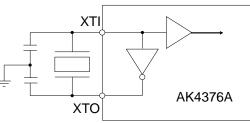


Figure 12. X'tal Mode

Note 69. The capacitor value is dependent on the crystal oscillator.

C_L = 21.5 pF (Max.), RI (Equivalent Series Resistance) = 80Ω (Max.) @ 24.576 MHz

 C_L = 30.6 pF (Max.), RI (Equivalent Series Resistance) = 200 Ω (Max.) @ 11.2896 MHz

2) External Clock Mode (PMOSC bit = "0")

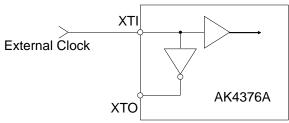


Figure 13. External Clock Mode Note 70. Do not input a clock more than AVDD.

3) OFF Mode (Not Using XTI/XTO pins (PMOSC bit = "0"))

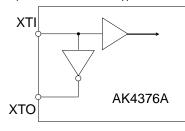


Figure 14. OFF Mode

■ DAC Digital Filter

The AK4376A has four types of digital filter. The filter mode of DAC can be selected by DASD and DASL bits. The default setting is DASL bit = DASD bit = "0" (Sharp Roll-Off Filter).

	DASD bit	DASL bit	DAC Filter Mode Setting			
	0	0	Sharp Roll-Off Filter	(default)		
	0	1	Slow Roll-Off Filter			
	1	0	Short Delay Sharp Roll-Off Filter			
	1	1	Short Delay Slow Roll-Off Filter			

Table 14. DAC Digital Filter Setting

Digital Mixing

The AK4376A has digital mixing circuits for each Lch and Rch. They can mix the data digitally and convert the polarity. The inverted data by this polarity conversion is calculated in 2's complement format.

MDACL bit	RDACL bit	LDACL bit	DAC Lch Input Data			
MDACR bit	RDACR bit	LDACR bit	DAC Rch Input Data			
0	0	0	MUTE	(default)		
0	0	1	Lch			
0	1	0	Rch			
0	1	1	Lch + Rch			
1	0	0	MUTE			
1	0	1	Lch/2			
1	1	0	Rch/2			
1	1	1	(Lch + Rch)/2			

Table 15.	DAC L/Rch	Input Signal	Select
-----------	-----------	--------------	--------

Table 16. DAC L/Rch Input Signal Polarity Select

INVL bit INVR bit	Output Data	
0	Normal	(default)
1	Inverting	

■ Digital Volume

The AK4376A has a 32-level digital volume in front of DAC for each L and R channel. The volume is changed from +3 dB to -12 dB in 0.5 dB step including Mute. The volume change is executed immediately by setting registers.

When OVOLCN bit is "1", the OVL[4:0] bits control Lch level and OVR[4:0] bits control Rch level. When OVOLCN bit = "0", the OVL[4:0] bits control both Lch and Rch attenuation levels. In this case, the setting of OVR[4:0] bits is ignored.

When Oct Speed Mode (fs = 256 to 384 kHz), Digital Volume cannot be used.

	al Volume Setting	
OVL[4:0] bits	Volume (dB)	
OVR[4:0] bits		
1FH	+3	
1EH	+2.5	
1DH	+2	
1CH	+1.5	
1BH	+1	
1AH	+0.5	
19H	0	(default)
18H	-0.5	
17H	1	
16H	-1.5	
15H	-2	
14H	-2.5	
13H	-3	
12H	-3.5	
11H	-4	
10H	-4.5	
0FH	-5	
0EH	-5.5	
0DH	-6	
0CH	-6.5	
0BH	-7	
0AH	-7.5	
09H	-8	
08H		
07H	-9	
06H	9.5	
05H	-10	
04H		
03H		
03H		
02/1 01H	-12	
01H 00H	MUTE	
	IVIUTE	l

Table 17. Digital Volume Setting

■ Headphone Amplifier Output (HPL/HPR pins)

Headphone amplifiers are operated by positive and negative power that is supplied from internal charge pump circuit. The VEE2 pin output the negative voltage generated by the internal charge pump circuit from CVDD. This charge pump circuit is switched between VDD mode and 1/2VDD mode by the output level of the headphone amplifiers. The headphone amplifier output is single-ended and centered on HPGND (0 V). A capacitor for AC coupling is not necessary. The load resistance is 14.4 Ω (Min.). The output power is 10 mW when 0 dBFS, R_L = 32 Ω , AVDD = CVDD = 1.8 V and HPG = -4 dB, and it is 25 mW when 0 dBFS, R_L = 32 Ω , AVDD = 1.8 V and HPG = 0 dB. Ground loop noise cancelling function for headphone amplifier is available by connecting the HPGND pin to the ground of the jack.

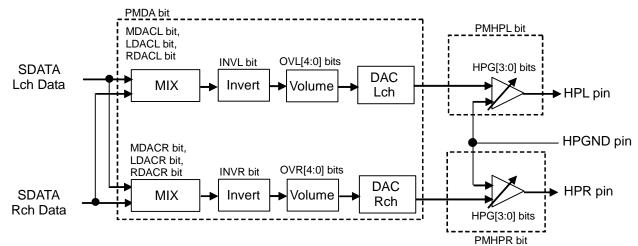


Figure 15. DAC & Headphone-Amp Block Diagram

CPMODE1 bit	CPMODE0 bit	Mode	Operation Voltage				
0	0	Class-G Operation Mode	Automatic Switching	(default)			
0	1	±VDD Operation Mode	±VDD				
1	0	±1/2 VDD Operation Mode	±1/2 VDD				
1	1	N/A	N/A				

Table 18. Charge Pump Mode Setting (N/A: Not available)

• Class-G Mode Switching Level:

VDD → 1/2 VDD: < 1.05 mW at both channels (@ CVDD = 1.8 V, $R_L = 32\Omega$) 1/2 VDD → VDD: ≥ 1.05 mW at either channel (@ CVDD = 1.8 V, $R_L = 32\Omega$)

When the charge pump operation mode is changed to VDD mode from 1/2 VDD mode, an internal counter for holding VDD mode starts (Table 19). The charge pump changes to 1/2 VDD mode if the output signal level is lower than the switching level and 1/2 VDD mode detection time that is set by LVDTM[2:0] bits is passed after VDD mode hold time is finished.

						-
VDDTM[3:0] bits			VDD Mode	Holding Peric	bd	
		8 kHz	44.1 kHz	96 kHz	192 kHz	
0000	1024/fs	128 ms	23.2 ms	10.7 ms	5.3 ms	(default)
0001	2048/fs	256 ms	46.4 ms	21.3 ms	10.7 ms	
0010	4096/fs	512 ms	92.9 ms	42.7 ms	21.3 ms	
0011	8192/fs	1024 ms	186 ms	85.3 ms	42.7 ms	
0100	16384/fs	2048 ms	372 ms	170.7 ms	85.3 ms	
0101	32768/fs	4096 ms	743 ms	341.3 ms	170.7 ms	
0110	65536/fs	8192 ms	1486 ms	682.7 ms	341.3 ms	
0111	131072/fs	16384 ms	2972 ms	1365.3 ms	682.7 ms	
1xxx	262144/fs	32768 ms	5944 ms	2730.7 ms	1365.3 ms	

Note 71. Oct speed mode (fs = 256 k / 352.8 k / 384 kHz) has the same cycle as fs = 32 k / 44.1 k / 48 kHz.

When the output voltage becomes less than class-G mode switching level, the internal detection counter for 1/2 VDD mode which is set by LVDTM[2:0] bits starts. This counter is reset when the output voltage exceeds class-G mode switching level. The charge pump operation mode is changed to VDD from 1/2 VDD if the detection counter of 1/2VDD mode is finished and also the VDD mode hold period is passed.

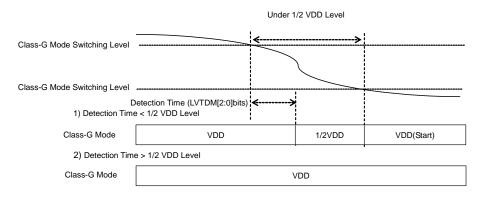


Figure 16. Transition to 1/2 VDD Mode from VDD Mode

	ZVDD Dele	JUON FENOU		equency mai		<u>-</u> u)	
		1/2 VDD Mode Detection Time /					
LVDTM[2:0] bits		Minimu	<u>m Frequenc</u>	y That Is Not	Detected		
		8 kHz	44.1 kHz	96 kHz	192 kHz		
000	64/fs	8 ms	1.5 ms	0.67 ms	0.33 ms	(default)	
000	04/15	62.5 Hz	344.5 Hz	750 Hz	1500 Hz	(uerauit)	
001	128/fs	16 ms	2.9 ms	1.3 ms	0.67 ms		
001	120/15	31.3 Hz	172.3 Hz	375 Hz	750 Hz		
010	256/fs	32 ms	5.8 ms	2.7 ms	1.3 ms		
010	250/15	15.6 Hz	86.1 Hz	187.5 Hz	375 Hz		
011	E10/fa	64 ms	11.6 ms	5.3 ms	2.7 ms		
011	512/fs	7.8 Hz	43.1 Hz	93.8 Hz	187.5 Hz		
100	1024/fs	128 ms	23.2 ms	10.7 ms	5.3 ms		
100	1024/15	3.9 Hz	21.5 Hz	46.9 Hz	93.8 Hz		
101	2048/fs	256 ms	46.4 ms	21.3 ms	10.7 ms		
101	2040/15	2.0 Hz	10.8 Hz	23.4 Hz	46.9 Hz		
110 409	4096/fs	512 ms	92.9 ms	42.7 ms	21.3 ms]	
	4090/15	1.0 Hz	5.4 Hz	11.7 Hz	23.4 Hz	1	
111	8192/fs	1024 ms	185.8 ms	92.9 ms	42.7 ms]	
	0192/15	0.5 Hz	2.7 Hz	5.9 Hz	11.7 Hz]	

Note 72. Oct speed mode (fs = 256 k / 352.8 k / 384 kHz) has the same cycle as fs = 32 k / 44.1 k / 48 kHz.

The output level of the headphone amplifier is controlled by HPG[3:0] bits. The volume setting is common for both L and R channels and ranges from +6dB to -20 dB in 2 dB step (Table 21). The volume change is executed immediately by setting registers.

Table 21. Headpho	ne Amplifier	Volume Setting	(N/A: Not available)

HPG[3:0] bits	Volume (dB)	
FH	N/A	
EH	+6	
DH	+4	
CH	+2	
BH	0	(default)
AH	-2	
9H	-4	
8H	-6	
7H	-8	
6H	-10	
5H	-12	
4H	-14	
3H	-16	
2H	-18	
1H	-20	
ОH	MUTE	

< Headphone Amplifier External Circuit >

It is necessary to put an oscillation prevention circuit (0.1 μ F ±20% capacitor and 10 Ω ±20% resistor) because there is a possibility that the headphone amplifier oscillates.

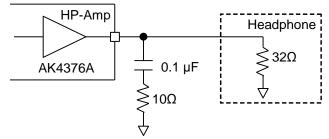


Figure 17. Headphone Amplifier Oscillation Prevention Circuit Example

< Power-Up/Down Sequence of Headphone Amplifier >

After releasing DAC power-down state by PMDA bit, the headphone amplifier should be powered up by PMHPL/R bits. A wait time from DAC power-up to headphone power-up is not necessary. PMDA bit releases a power-down of the digital block of the DAC, PMHPL bit or PMHPR bit powers up the analog block of the DAC and the headphone amplifier. Then, initialization cycle of the headphone amplifier is executed. The gain setting (HPG[3:0] bits) should be made before PMHPL bit or PMHPR bit is set to "1". Do not change the gain setting (HPG[3:0] bits) during the headphone initialization cycle. The gain setting can be changed after the headphone initialization cycle is finished. A wait time from the gain setting to PMHPL bit or PMHPR bit = "1" is not necessary.

When the AK4376A is powered down, the headphone amplifier should be powered down first. The DAC should be powered down next. A wait time from a headphone power-down to the DAC power-down is not necessary.

When the headphone amplifier is powered down, the HPL pin and the HPR pin are pulled down to HPGND via the internal pull-down register. The pull-down resistor is 6Ω (Typ.) @ HPLHZ bit = HPRHZ bit = "0". When the headphone amplifier is powered down, the HPL pin and the HPR pin are pulled down by 200 k Ω (Typ.) by setting HPLHZ bit and HPRHZ bit to "1", respectively. These bits must be set to "0" before power up the headphone amplifier.

PMHPL bit HPLHZ bit		HP-Amp Status		
0	0	Pull-Down by 6Ω (Typ.)		
0	1	Pull-Down by 200 kΩ (Typ.)		
1	0	Normal Operation		
1	1	N/A		

Table 22. Headphone Lch Output Status (N/A: Not available)

Table 23. Headphone Rch Output Status (N/A: Not available)

PMHPR bit HPRHZ bit		HP-Amp Status
0 0		Pull-Down by 6Ω (Typ.)
0	1	Pull-Down by 200 kΩ (Typ.)
1	0	Normal Operation
1	1	N/A

When the HPL pin and the HPR pin are connected to analog signal pins of an external device by Wire-OR, CP1, CP2, LDO1P and LDO1N should be powered up. Do not input a negative voltage to the HPL and the HPR pins when CP1, CP2, LDO1P and LDO1N are powered down.

If the pop noise at power-down exceeds an acceptable range, headphone amplifier should be powered down after attenuating the headphone volume gradually until mute.

The power-up time of headphone amplifier is shown in Table 24. The HPL pin and the HPR pin output 0 V (HPGND) when the headphone amplifier is powered up. The power-down is executed immediately.

Table 24. Headphone Power Up Time			
Sampling Frequency [kHz]	Power-Up Time (Max.)		
8/12/16/24/32/48/64/96/128/192/256/384	23.9 ms		
11.025/22.05/44.1/88.2/176.4/352.8	25.9 ms		

<Power-Up Sequence Example>

- 1. DAC Initial Settings (Write "20H" data into DAC Adjustment1 (Addr.26H), Write "05H" data into DAC Adjustment2 (Addr.2AH)) (Note 73)
- 2. Audio I/F, DAC Clock, Sampling Frequency, Path, Digital Volume, Analog Volume Settings
- CP1 Power-Up (PMCP1 bit: "0" \rightarrow "1") 3.
- Wait 6.5 ms (Note 74) 4.
- 5. LDO1P & LDO1N Power-Up (PMLDO1P bit & PMLDO1N bit: "0" \rightarrow "1")
- Wait 1 ms (Note 74) 6.
- DAC Power-Up (PMDA bit: "0" \rightarrow "1") 7.
- CP2 Power-Up (PMCP2 bit: "0" \rightarrow "1") 8.
- Wait 4.5 ms (Note 74) 9.
- 10. Headphone Amplifier Power-Up (PMHPL bit & PMHPR bit: " $0^{\circ} \rightarrow$ "1")
- 11. Wait 25.9 ms (@ fs = 44.1 kHz)
- 12. Plavback

<Power-Down Sequence Example>

- Headphone Amplifier Power-Down (PMHPL bit & PMHPR bit: "1" \rightarrow "0") 1
- CP2 Power-Down (PMCP2 bit: "1" \rightarrow "0") DAC Power-Down (PMDA bit: "1" \rightarrow "0") 2.
- 3.
- 4. LDO1P & LDO1N Power-Down (PMLDO1P bit & PMLDO1N bit: "1" \rightarrow "0")
- CP1 Power-Down (PMCP1 bit: "1" \rightarrow "0") 5.
- 6. Stop
- Note 73. Recommended setting of DAC Adjustment2 (Addr.2AH) is "05H" data. However, T[15:12] bits setting should be changed appropriately since the optimum setting for T[15:12] bits varies depending on the PCB layout.

Note 74. Refer to " Charge Pump & LDO Circuit Power-up Time"

< Low Power Mode >

The DAC and the headphone amplifier will be in low power mode by setting LPMODE bit and DSMLP bit to "1". PMHPL bit and PMHPR bit must be set to "0" when changing operation mode of the DAC and the headphone amplifier between low power mode and high performance mode. The AK4376A does not support Oct speed mode (fs= 256 to 384 kHz) in low power mode.

Table 25. D	AC, HP-Amp	Mode Setting
-------------	------------	--------------

Table 25. DAC		
LPMODE bit		
0	High Performance Mode	(default)
1	Low Power Mode	

< Noise Gate >

When NGDIS bit = "0", a noise gate is enabled and noise level will be improved if both L and R channels input data of the DAC is continuously "0" for the period set by NGT and FS[4:0] bits. The noise gate will be disabled if one of these L channel and R channel input data of the DAC is not "0" even once and the AK4376A returns to normal operation from the state that Noise gate is enabled. The noise gate is always disable when NGDIS bit = "1" or when LPMODE bit = "1" (in low power mode). It is only available in high performance mode (LPMODE bit = "0"). PMDA bit, PMHPL bit and PMHPR bit must be set to "0" when changing NGT bit.

0 0 1 0 0 16 kHz 128.0 ms 204 0 0 1 0 1 22.05 kHz 92.9 ms 204 0 0 1 1 0 24 kHz 85.3 ms 204 0 1 0 0 32 kHz 128.0 ms 409 0 1 0 0 1 44.1 kHz 92.9 ms 409 0 1 0 0 1 44.1 kHz 92.9 ms 409 0 1 0 0 44.1 kHz 92.9 ms 409 0 1 1 0 0 64 kHz 128.0 ms 819 0 1 1 0 1 85.3 ms 819 1 0 0 1 176.4 kHz 92.9 ms 163 1 0 1 0 128 kHz 128.0 ms 327 1 0 1 0 1352.8	Time
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1 0 1 1 0 0 64 kHz 256.0 ms 163)2/fs
	84/fs
	84/fs
	84/fs
	68/fs
	68/fs
	68/fs
	36/fs
	36/fs
	36/fs
	/A

Table 26. Noise Gate Zero Detection Period (N/A: Not available)

Table 27. Noise Gate Setting				
NGDIS bit Noise Gate Status				
0	(default)			
1	Disable			

< Overcurrent Protection Circuit >

If the headphone amplifier is in an overcurrent state, such as when output pins are shorted, the headphone amplifier limits the operation current. The headphone amplifier returns to a normal operation state if all causes are cleared.

■ Charge Pump & LDO Circuits

The charge pump circuits are operated by CVDD power supply voltage. CVDD is used to generate negative voltage. The power-up/down sequence of charge pump and LDO circuits are as follows. CP1 should be powered up before LDO1P/N are powered up. CP2 should be powered up after LDO1P/N are powered up. LDO1P and LDO1N blocks must be powered up or down at the same time.

Power-Up Sequence: CP1 \rightarrow LD01P, LD01N \rightarrow CP2 Power-Down Sequence: CP2 \rightarrow LD01P, LD01N \rightarrow CP1

LDO1P and LDO1N have an overcurrent protection circuit. When overcurrent flows in a normal operation, the LDO1P and LDO1N circuits limit the operation current. If the over current state is cleared, the overcurrent protection will be off and the LDO1P and LDO1N circuits will return to normal operation.

LDO2 has an overvoltage protection circuit. This overvoltage protection circuit powers the LDO2 down when the power supply becomes unstable by an instantaneous power failure, etc. during operation. The LDO2 circuit will not return to a normal operation until being reset by the PDN pin ("L" \rightarrow "H") after removing the problems.

The charge pump and the LDO circuits can be powered up again while they are in power-down state.

Charge Pump	Power Management bit	Input Voltage	Output Voltage (Typ.)	Operation Block
CP1	PMCP1	CVDD	–1.8 V	LDO1N DAC
CP2 (Class-G)	PMCP2	CVDD	±1.8 V / ±0.9 V	HP

Table 28. Input/Output Voltage and Operation Block of the Charge Pump

Table 29. Input/Output Voltage and Operation Block of the LDO					
LDO	Power Management bit	Power Supply	Output Voltage (Typ.)	Operation Block	
LDO1P	PMLDO1P	AVDD / VSS1	+1.5 V	VREF+ for DAC, HP	
LDO1N	PMLDO1N	VSS1 / CP2 Output	–1.5 V	VREF- for DAC, HP	
LDO2	-	LVDD / VSS1	+1.2 V	Digital Core	

Table 29. Input/Output Voltage and Operation Block of the LDO

Serial Audio Interface

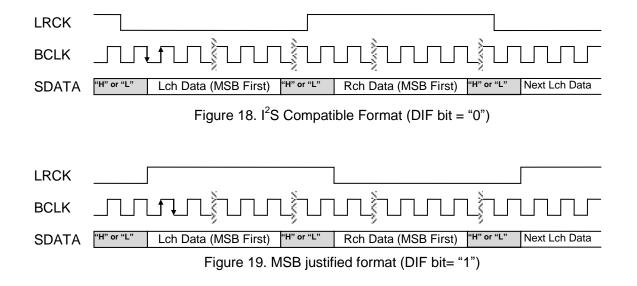
The serial audio interface format is set by DIF bit and its data length is controlled by DL[1:0] bits. In case that the input data length is less than the value which set by DL[1:0] bits, unused lower bits are filled with "0". When using master mode, DL[1:0] bits is set in accordance with the setting of BCKO bit.

Table 30. Digital I/F Format Setting	
--------------------------------------	--

DIF bit	Digital I/F Format	
0	I ² S Compatible	(default)
1	MSB justified	

	DL0 bit	Data Langth		BCLK Frequency	1
DL1 bit	DL0 DI	Data Length	Slave Mode	Master Mode]
0	0	24-bit linear	\geq 48fs	64fs (BCKO bit = "0")	(default)
0	1	16-bit linear	≥ 32fs	32fs (BCKO bit = "1")	
1	x	32-bit linear	≥ 64fs	64fs (BCKO bit = "0")	

Table 31. Data Length Setting (x: Do not care)



■ Power-up & Operation Mode

Power Down State (PDN pin = "L")

When the PDN pin is "L", the AK4376A is in a power-down state. Power supplies must be applied when the PDN pin = "L". Set the PDN pin to "H" to release the power-down state after all the power supplies are on. More than one tPDN cycle of "L" period is needed before releasing the power-down state. The state of the AK4376A transitions to LDO2 Ctrl state by bringing the PDN pin to "H".

LDO2 Ctrl State

This is a state to control the LDO2.

LDO2 is powered up and the internal DRSTN signal is changed from "L" to "H" after max. 1 ms, and the AK4376A enters a Standby state.

Standby State

I²C interface is powered up and register accesses are enabled.

*10ms (min.) wait time for power-up of analog circuit blocks (CP1, CP2, LDO1P, LDO1N, DAC, HP-Amp and PLL) is needed after setting the PDN pin to"H" to release the power-down state.

<State Transition Diagram>

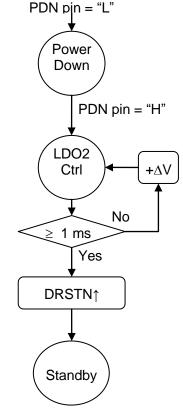


Figure 20. Device State Diagram

1. PDN pin "L" \rightarrow "H"

- 2. Wait 1 ms until LDO2 1.2V output is stable.
- 3. Internal DRSTN Signal: "L" → "H"

4. Register Access Ready

■ Serial Control Interface (I²C-bus)

The AK4376A supports the fast-mode I^2 C-bus (max: 400 kHz). Pull-up resistors at the SDA and SCL pins must be connected to (TVDD +0.3) V or less voltage.

1. WRITE Operation

Figure 21 shows the data transfer sequence for the I²C-bus mode. All commands are preceded by a START condition. A HIGH to LOW transition on the SDA line while SCL is HIGH indicates a START condition (Figure 27). After the START condition, a slave address is sent. This address is 7 bits long followed by the eighth bit that is a data direction bit (R/W). The most significant seven bits of the slave address are fixed as "0010000". If the slave address matches that of the AK4376A, the AK4376A generates an acknowledge and the operation is executed. The master must generate the acknowledge-related clock pulse and release the SDA line (HIGH) during the acknowledge clock pulse (Figure 28). A R/W bit value of "1" indicates that the read operation is to be executed, and "0" indicates that the write operation is to be executed.

The second byte consists of the control register address of the AK4376A. The format is MSB first 8 bits (Figure 23). The data after the second byte contains control data. The format is MSB first, 8 bits (Figure 24). The AK4376A generates an acknowledge after each byte is received. Data transfer is always terminated by a STOP condition generated by the master. A LOW to HIGH transition on the SDA line while SCL is HIGH defines a STOP condition (Figure 27).

The AK4376A can perform more than one byte write operation per sequence. After receipt of the third byte the AK4376A generates an acknowledge and awaits the next data. The master can transmit more than one byte instead of terminating the write cycle after the first data byte is transferred. After receiving each data packet the internal address counter is incremented by one, and the next data is automatically taken into the next address. If the address exceeds "15H" prior to generating a stop condition, the address counter will "roll over" to "00H" and the previous data will be overwritten.

The data on the SDA line must remain stable during the HIGH period of the clock. HIGH or LOW state of the data line can only be changed when the clock signal on the SCL line is LOW (Figure 29) except for the START and STOP conditions.

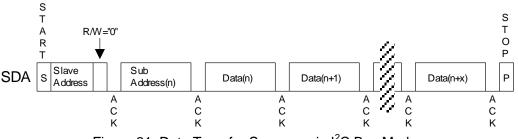


Figure 21. Data Transfer Sequence in I²C Bus Mode

0	0	1	0	0	0	0	R/W				
		Figu	re 22. Th	e First B	yte						
A7	A6	A5	A4	A3	A2	A1	A0				
		Figure	23. The	Second	Byte						
D7	D6	D5	D4	D3	D2	D1	D0				
	Figure 24. The Third Byte										

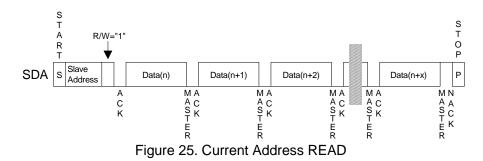
2. READ Operation

Set the R/W bit = "1" for the READ operation of the AK4376A. After transmission of data, the master can read the next address's data by generating an acknowledge instead of terminating the write cycle after the receipt of the first data word. After receiving each data packet the internal address counter is incremented by one, and the next data is automatically taken into the next address. If the address exceeds "15H" prior to generating stop condition, the address counter will "roll over" to "00H" and the data of "00H" will be read out.

The AK4376A supports two basic read operations: Current Address READ and Random Address READ.

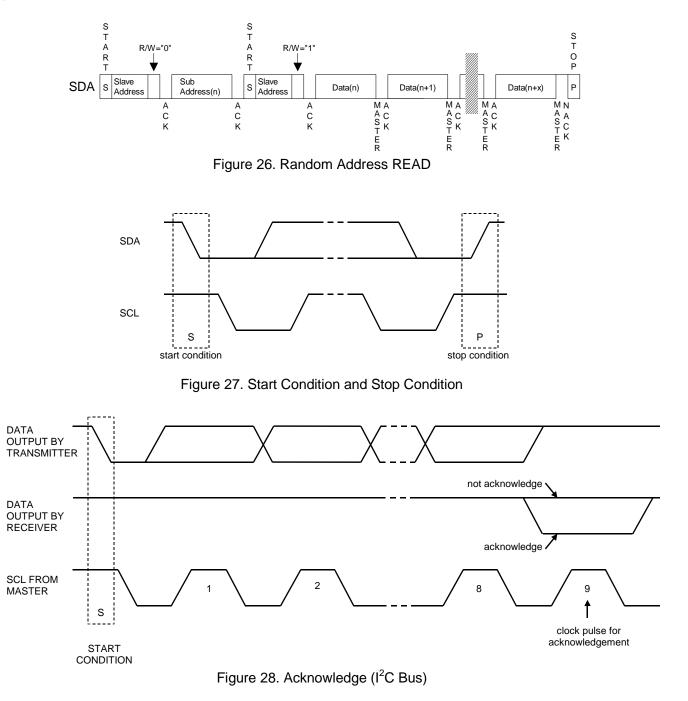
2-1. Current Address READ

The AK4376A has an internal address counter that maintains the address of the last accessed word incremented by one. Therefore, if the last access (either a read or write) were to address "n", the next Current READ operation would access data from the address "n+1". After receipt of the slave address with R/W bit "1", the AK4376A generates an acknowledge, transmits 1-byte of data to the address set by the internal address counter and increments the internal address counter by 1. If the master does not generate an acknowledge but generates a stop condition instead, the AK4376A ceases the transmission.



2-2. Random Address READ

The random read operation allows the master to access any memory location at random. Prior to issuing the slave address with the R/W bit "1", the master must first perform a "dummy" write operation. The master issues a start request, a slave address (R/W bit = "0") and then the register address to read. After the register address is acknowledged, the master immediately reissues the start request and the slave address with the R/W bit "1". The AK4376A then generates an acknowledge, 1 byte of data and increments the internal address counter by 1. If the master does not generate an acknowledge but generates a stop condition instead, the AK4376A ceases the transmission.



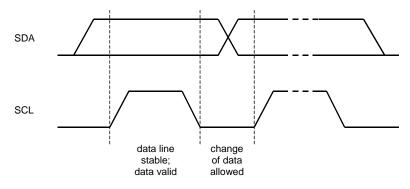


Figure 29. Bit Transfer (I²C Bus)

■ Control Sequence

Figure 30 shows power up sequence of the headphone amplifier.

Power Supply		
PDN pin	10 ms	₹
Analog Circuit Power		
MCKI, BCLK, LRCK	1 ms	
DAC Initial Setting	Addr.26H="40H" Addr.2AH="00H"	(Addr.26H) ="20H" (Addr.2AH) ="05H"
FS[4:0] bits (Addr:05H, D4 - D0)	00000	l 01001
LDACL bit RDACR bit (Addr:07H, D5, D0)		
OVL[4:0] bits	11001	l I 10001
(Addr:0BH, D4-D0)	/ \	+
PMCP1 bit		
(Addr:01H, D0)		
PMLDO1P bit		
PMLDO1N bit (Addr:01H, D5, D4)		 11ms
PMDA bit (Addr:02H, D0)		<u> </u>
(Addi .02H, D0)		
PMCP2 bit		
(Addr:01H, D1)		4.5 m s
PMHPL bit PMHPR bit (Addr:03H, D1, D0)		25.9 m s
HPL pin HPR pin		Normal Operation

Figure 30. Power Up Sequence Example of Headphone Amplifier

<Sequence>

- (1) Set the PDN pin "L" → "H" after the AK4376A is powered up. In this case, 1ms or more "L" time is needed for a certain reset. (MCKI, BCLK, LRCK, SDATA, SCL and SDA should be input after all power supplies are ON.)
- (2) Set the PDN pin = "H" to release the power down. Register access will be valid after 0.8 ms. However, a wait time of 10 ms is needed to access power management bits of the analog circuit (PMCP1 bit, PMCP2 bit, PMLDO1P bit, PMLDO1N bit, PMDAC bit, PMHPL bit, PMHPR bit, PMPLL bit) until the analog circuit is powered up. Execute register write after analog circuit is powered up.
- (3) Input MCKI, BCLK and LRCK.
- (4) Set sampling frequency (FS[4:0] bits) and the input signal path of the DAC (LDACL bit = RDACR bit = "0" → "1").
- (5) Set DAC digital volume by OVL[4:0] bits. Both Lch and Rch volumes are controlled by OVL[4:0] bits when OVOLCN bit = "1" (default).
 (6) Devenue CD1 (DMOD1 bit = "0" - = "1")
- (6) Power up CP1 (PMCP1 bit= "0" → "1")
 LDO1P and LDO1N should be powered up (PMLDO1P bit = PMLDO1N bit = "0"→"1") after
 6.5 ms (Note 75) from CP1 power-up.
- (7) Power up DAC (PMDA bit = "0" → "1")
 DAC must be powered up after 1 ms (Note 75) from LDO1P and LDO2P power up.
- (8) Power up CP2 (PMCP2 bit = "0" → "1")
 CP2 must be powered up after LDO1P and LDO1N are powered up.
- (9) Power up HPL and HPR (PMHPL bit = PMHPR bit = "0" → "1") HPL and HPR should be powered up after 4.5 ms (Note 75) from CP2 power up. The power-up time of HP-Amp is 25.9 ms (@ fs = 44.1 kHz). The HPL pin and the HPR pin output 0 V until the HP-Amp is powered up.

Note 75. Refer to "■ Charge Pump & LDO Circuit Power-up Time"

Register Map

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0	
	Power Management 1	0	0	0	PMOSC	0	0	0	PMPLL	
	Power Management 2	0	0	PMLDO1N	PMLDO1P	0	0	PMCP2	PMCP1	
02H	Power Management 3	0	0	0	LPMODE	0	0	0	PMDA	
03H	Power Management 4	0		LVDTM[2:0]]	CPMO	DE[1:0]	PMHPR	PMHPL	
04H	Output Mode Setting	0	0		VDDT	M[3:0]		HPRHZ	HPLHZ	
05H	Clock Mode Select	0	CM	[1:0]			FS[4:0]			
06H	Digital Filter Select	DASD	DASL	0	0	T1	0	NGT	NGDIS	
07H	DAC Mono Mixing	INVR	MDACR	RDACR	LDACR	INVL	MDACL	RDACL	LDACL	
08H	Reserved	0	0	0	0	0	0	0	0	
09H	Reserved	0	0	0	0	0	0	0	0	
0AH	Reserved	0	0	0	0	0	0	0	0	
0BH	Lch Output Volume	OVOLCN	0	0		OVL[4:0]				
0CH	Rch Output Volume	0	0	0			OVR[4:0]			
0DH	HP Volume Control	0	0	0	0		HPG	[3:0]		
0EH	PLL CLK Source Select	0	0	T2	0	0	0	PLS[1:0]	
	PLL Ref CLK Divider 1				PLD[1	15:8]				
	PLL Ref CLK Divider 2				PLD[7:0]				
	PLL FB CLK Divider 1				PLM[15:8]				
12H	PLL FB CLK Divider 2			-	PLM[7:0]				
13H	DAC CLK Source	0	0	0	0	0	0	DACCK	[1:0]	
	DAC CLK Divider				MDIV	[7:0]				
15H	Audio I/F Format	DE	VICEID[2:0]	MS	BCKO	DIF	DL[´	1:0]	
21H	CHIP ID	0	T101	T100	0	0	0 CHIPID[2:0]			
24H	Mode Control	0	DSMLP	0	Т3	0	0	0	0	
26H	DAC Adjustment1	T11	T10	Т9	Т8	T7	T6	T5	T4	
2AH	DAC Adjustment2	T19	T18	T17	T16	T15	T14	T13	T12	

Note 76. PDN pin = "L" resets the registers to their default values.

Note 77. The bits defined as "0" must contain a "0" value.

Note 78. Writing access from 16H to 20H, 22H, 23H, 25H, 27H to 29H and 2BH to FFH is prohibited.

Register Definitions

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
00H	Power Management 1	0	0	0	PMOSC	0	0	0	PMPLL
	R/W	R	R	R	R/W	R	R	R	R/W
	Default	0	0	0	0	0	0	0	0

PMPLL: PLL Power Management

0: Power-Down (default)

1: Power-Up

PMOSC: Crystal Oscillator Power Management

0: Power-Down (default)

1: Power-Up

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
01H	Power Management 2	0	0	PMLDO1N	PMLDO1P	0	0	PMCP2	PMCP1
	R/W	R	R	R/W	R/W	R	R	R/W	R/W
	Default	0	0	0	0	0	0	0	0

PMCP1: Charge Pump 1 Power Management

0: Power-Down (default)

1: Power-Up

PMCP2: Charge Pump 2 Power Management

- 0: Power-Down (default)
- 1: Power-Up

PMLDO1P: LDO1P Power Management

- 0: Power-Down (default)
- 1: Power-Up

PMLDO1N: LDO1N Power Management

- 0: Power-Down (default)
- 1: Power-Up

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
02H	Power Management 3	0	0	0	LPMODE	0	0	0	PMDA
	R/W	R	R	R	R/W	R	R	R	R/W
	Default	0	0	0	0	0	0	0	0

PMDA: DACDIG Power Management

0: Power-Down (default)

1: Power-Up

LPMODE: DAC & HP-Amp Low Power Mode Setting

0: High Performance Mode (default)

1: Low Power Mode

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
03H	Power Management 4	0	L	.VDTM[2:0]		CPMO	DE[1:0]	PMHPR	PMHPL
	R/W	R	R/W			R/W		R/W	R/W
	Default 0		000			0	0	0	0

PMHPL/R: HP-Amp L/Rch Power Management

0: Power-Down (default)

1: Power-Up

CPMODE[1:0]: Charge Pump Mode Control (Table 18) Default: "00" (Automatic Switching Mode)

LVDTM[2:0]: Class-G 1/2VDD Mode Detection Time Setting (Table 20) Default: "000" (64/fs)

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
04H	Output Mode Setting	0	0		VDDT	HPRHZ	HPLHZ		
	R/W	R	R		R/	R/W	R/W		
	Default	0	0	0000				0	0

HPRHZ/HPLHZ: GND Switch Setting for HP-Amp Output

0: Pull-Down by 6Ω (Typ.) (default)

1: Pull-Down by 200 k Ω (Typ.)

VDDTM[3:0]: Class-G VDD Mode Hold Time Setting (Table 19) Default: "0000" (1024/fs)

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0	
05H	Clock Mode Select	0	CM[1:0]		FS[4:0]					
	R/W	R	R/W		R/W					
	Default 0		00		0 0000					

FS[4:0]: Sampling Frequency Setting (Table 5) Default: "00000" (fs = 8 kHz)

CM[1:0]: Master Clock Setting (Table 3, Table 4)

Default: "00" (256fs @Normal/Double Speed Mode / 32fs @Oct Speed Mode)

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
06H	Digital Filter Select	DASD	DASL	0	0	T1	0	NGT	NGDIS
	R/W	R/W	R/W	R	R	R/W	R	R/W	R/W
	Default	0	0	0	0	0	0	0	0

NGDIS: Noise Gate Setting

- 0: Noise Gate Enable (default)
- 1: Noise Gate Disable
- NGT: Noise Gate Timer Setting (Table 26) Default: "0"

T1: Write "0" into this bit.

DASD, DASL: DAC Digital Filter Mode Setting (Table 14) Default: "0, 0" (Sharp Roll-Off Filter)

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
07H	DAC Mono Mixing	INVR	MDACR	RDACR	LDACR	INVL	MDACL	RDACL	LDACL
	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
	Default	0	0	0	0	0	0	0	0

MDACL, RDACL, LDACL: DAC Lch Input Signal Select (Table 15) Default: "0, 0, 0" (MUTE)

MDACR, RDACR, LDACR: DAC Rch Input Signal Select (Table 15) Default: "0, 0, 0" (MUTE)

INVL/R: DAC Input Signal Polarity Select

0: Normal (default)

1: Inverting

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
08H 09H 0AH	Reserved	0	0	0	0	0	0	0	0
	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
	Default	0	0	0	0	0	0	0	0

Write "0" to the addresses from 08H to 0AH.

Addr	Register Name	D7	D6	D5	D4 D3 D2 D1 D0					
0BH	Lch Output Volume	OVOLCN	0	0	OVL[4:0]					
0CH	Rch Output Volume	0	0	0	OVR[4:0]					
	R/W	R/W	R	R	R/W					
	Default	0	0	0	19H					

OVL[4:0]: DAC Lch Digital Volume Control; +3 dB to -12 dB & Mute, 0.5 dB step (Table 17) OVR[4:0]: DAC Rch Digital Volume Control; +3 dB to -12 dB & Mute, 0.5 dB step (Table 17) Default: "19H" (0 dB)

OVOLCN: Digital Volume Control

0: Dependent (default)

1: Independent

OVL[4:0] bits control digital volume of both L and R channels when OVOLCN bit = "0". In this case, the value of OVL[4:0] bits will not be written to OVR[4:0] bits.

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
0DH	HP Volume Control	0	0	0	0	HPG[3:0]			
	R/W	R	R	R	R	R/W			
	Default		0	0	0	BH			

HPG[3:0]: HP-Amp Analog Volume Control; +6 dB to -20 dB, 2 dB step (Table 21) Default: BH (0 dB)

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1 D0
0EH PLL CLK Source Select		0	0	T2	0	0	0	PLS[1:0]
	R/W		R	R/W	R	R	R	R/W
Default		0	0	0	0	0	0	00

PLS[1:0]: PLL Clock Source Select (Table 7) Default: "00" (MCKI pin)

T2: Write "0" into this bit.

Addr	Register Name	D7	D7 D6 D5 D4 D3 D2 D1 D0									
0FH	PLL Ref CLK Divider 1		PLD[15:8]									
10H	PLL Ref CLK Divider 2		PLD[7:0]									
	R/W				R/	W						
	Default	0000H										

PLD[15:0]: PLL Reference Clock Divider Setting (Table 8) Default: 0000H (Divided by 1)

Addr	Register Name	D7	D7 D6 D5 D4 D3 D2 D1 D0									
11H	PLL FB CLK Divider 1		PLM[15:8]									
12H	PLL FB CLK Divider 2		PLM[7:0]									
	R/W				R/M	/						
	Default	0000H										

PLM[15:0]: PLL Feedback Clock Divider Setting (Table 9) Default: 0000H (Clock Stop)

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
13H DAC CLK Source		0	0	0	0	0	0	DACCI	(S[1:0]
	R/W		R	R	R	R	R	R/	W
	Default		0	0	0	0	0	0	0

DACCKS[1:0]: DAC Master Clock Source Select (Table 1) Default: "00" (MCKI pin)

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0			
14H	DAC CLK Divider		MDIV[7:0]									
	R/W				R/M	/						
Default 00H												

MDIV[7:0]: DACMCLK Divider Setting (Table 13) Default: 00H (Divided by 1)

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
15H	5H CODEC I/F Format DEVICEID[2:0]				MS	BCKO	DIF	DL[1:0]
	R/W	R	R	R	R/W	R/W	R/W	R/	W
	Default		1	0	0	0	0	0	0

DL[1:0]: Data Length Setting (Table 31) Default: "00" (24-bit linear)

DIF: Digital I/F Format Setting (Table 30) Default: "0" (I²S Compatible)

BCKO: BCLK Output Frequency

- 0: 64fs (default)
- 1: 32fs

MS: Master/Slave Mode Setting

0: Slave Mode (default)

- 1: Master Mode
- DEVICEID[2:0]: Device ID Default: "010" (AK4376, AK4376A: "010")

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
21H	CHIPID	0	T101	T100	0	0	CHIPID[2:0]		
	R/W		R/W	R/W	R	R	R	R	R
	Default	0	0	0	0	0	0	0	1

CHIPID[2:0]: CHIPID

Default: "001" (AK4376: "000", AK4376A: "001")

T101, T100: Write "0" into these bits.

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
24H	Mode Control	0	DSMLP	0	T3	0	0	0	0
	R/W	R	R/W	R	R/W	R	R	R	R
	Default	0	0	0	0	0	0	0	0

DSMLP: DAC Operation Mode Setting (Table 3, Table 4) Default: "0"

T3: Write "0" into this bit.

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
26H	DAC Adjustment1	T11	T10	Т9	T8	T7	T6	T5	T4
	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
	Default	0	1	0	0	0	0	0	0

*"20H" data must be written to DAC Adjustment1 (Addr.26H) before analog blocks (CP1, CP2, LDO1, DAC, HP-Amp, PLL) are powered up

Addr	Register Name	D7	D6	D5	D4	D3	D2	D1	D0
2AH	DAC Adjustment2	T19	T18	T17	T16	T15	T14	T13	T12
	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
	Default	0	0	0	0	0	0	0	0

T19, T18, T17, T16: Write "0" into these bits

T15, T14, T13, T12: DAC Adjustment Setting Default: "0000"

*Write "05H" to DAC Adjustment2 (Addr.2AH) before the analog block (CP1, CP2, LDO1, DAC, HP-Amp, PLL) is powered up.

*Recommended setting of DAC Adjustment2 (Addr.2AH) is "05H" data.

However, T[15:12] bits setting should be changed appropriately since the optimum setting for T[15:12] bits varies depending on the PCB layout.

10. Recommended External Circuits

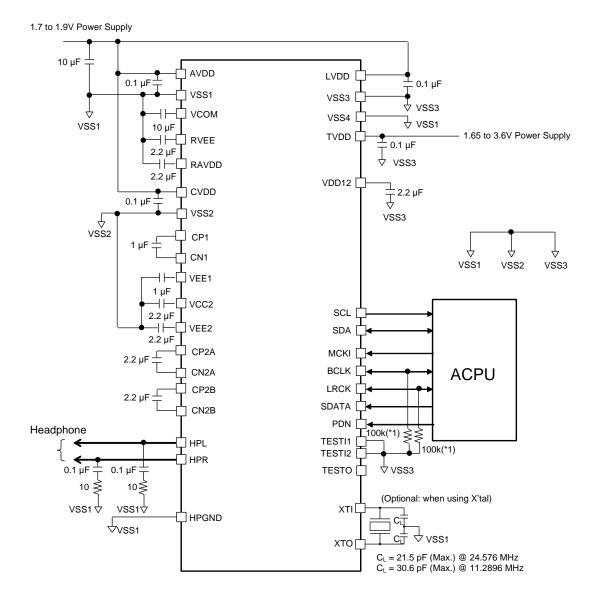


Figure 31. System Connection Diagram

*1: When the AK4376A is in master mode, a pull-down resistor (e.g. 100 k Ω) is needed.

1. Grounding and Power Supply Decoupling

The AK4376A requires careful attention to power supply and grounding arrangements. The PDN pin should be held "L" when power supplies are tuning on. AVDD should be powered up before or at the same time of CVDD. Power-up sequence of TVDD and LVDD is not critical. The PDN pin is allowed to be "H" after all power supplies are applied and settled. To power down the AK4376A, set the PDN pin to "L" and power down CVDD before or at the same time of AVDD. Power-down sequence of LVDD and TVDD is not critical.

To avoid pop noise on analog output when power up/down, the AK4376A should be operated along the following recommended power-up/down sequence.

1) Power-up

- The PDN pin should be held "L" when power supplies are turning on. The AK4376A can be reset by keeping the PDN pin "L" for 1 ms or longer after all power supplies are applied and settled. Then release the reset by setting the PDN pin to "H".

2) Power-down

- Each of power supplies can be powered OFF after the PDN pin is set to "L".

VSS1, VSS2, VSS3 and VSS4 of the AK4376A should be connected to the analog ground plane. System analog ground and digital ground should be connected together near where the supplies are brought onto the printed circuit board. Decoupling capacitors should be as close the power supply pins as possible. Especially, the small value ceramic capacitor is to be closest.

2. Voltage Reference

VCOM is a common voltage of this chip. A 10 μ F ceramic capacitor attached between the VCOM pin eliminates the effects of high frequency noise. No load current is allowed to be drawn from the VCOM pin. All signals, especially clocks, should be kept away from the VCOM pin in order to avoid unwanted coupling into the AK4376A.

3. Charge Pump and LDO Circuits

Capacitors for CP1 block (connected between the CP1 pin and the CN1 pin, between the VEE1 pin and the VSS2 pin) should be low ESR 1.0 μ F ±50%. Capacitors for LDO1 block (connected between the RAVDD pin and the VSS1 pin, between the RVEE pin and the VSS1 pin) should be low ESR from 1.0 μ F±50% to 4.7 μ F±50%.

Capacitors for CP2 block (connected between the CP2A pin and the CN2A pin, between the CP2B pin and the CN2B pin, between the VCC2 pin and the VSS2 pin, between the VEE2 pin and the VSS2 pin) should be low ESR 2.2 μ F ±50%. These capacitors must be connected as close as possible to the pins. No load current may be drawn from the Positive / Negative Power Output pin (VEE1, RAVDD, RVEE, VCC2 and VEE2 pins).

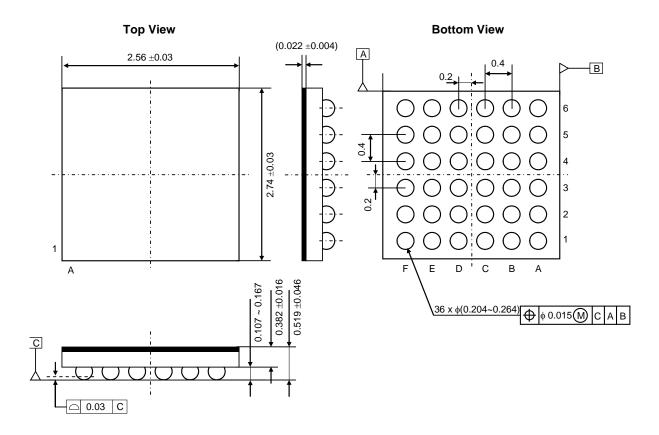
4. Analog Outputs

Headphone outputs are single-ended and centered at HPGND (0 V). A headphone can be driven directly since a capacitor for AC coupling is not necessary.

11. Package

Outline Dimensions

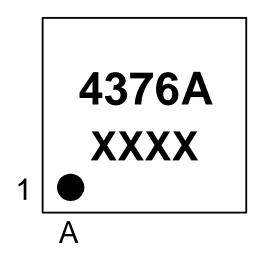
36-pin CSP (Unit: mm)



Material and Lead Finish

Package molding compound: Epoxy Resign, Halogen Free Lead frame material: SnAgCu

Marking



XXXX: Date code (4 digits) Pin #A1 indication

12. Ordering Guide

AK4376AECB –40 to 85 °C 36-pin CSP (0.4 mm pitch) AKD4376A Evaluation board for AK4376A

13. Revision History

Date (Y/M/D)	Revision	Reason	Page	Contents
16/11/09	00	First Edition		

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